

# CoolSET™ F3R80 ICE3AR1580VJZ

Off-Line SMPS Current Mode Controller with  
integrated 800V CoolMOS™ and Startup cell  
(input OVP & frequency jitter) in DIP-7

Data Sheet  
V2.0 2014-01-20

Power Management & Multimarket

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## Revision History

### Major changes since previous revision

Date	Version	Changed By	Change Description
20 Jan 2014	2.0		Release of first version

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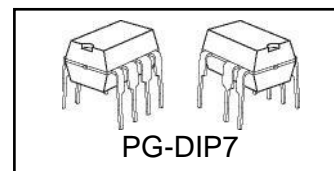
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## Off-Line SMPS Current Mode Controller with integrated 800V CoolMOS™ and Startup cell (input OVP & frequency jitter) in DIP-7

### Product Highlights

- 800V avalanche rugged CoolMOS™ with startup cell
- Active Burst Mode to reach the lowest Standby Power <100mW
- Selectable entry and exit burst mode level
- Adjustable blanking Window for high load jumps
- Frequency jitter and soft driving for low EMI
- Adjustable input OVP
- Auto Restart protection for over load, over temperature and over voltage
- Low Operating temperature down to -40°C
- Pb-free lead plating, halogen free mold compound, RoHS compliant



### Features

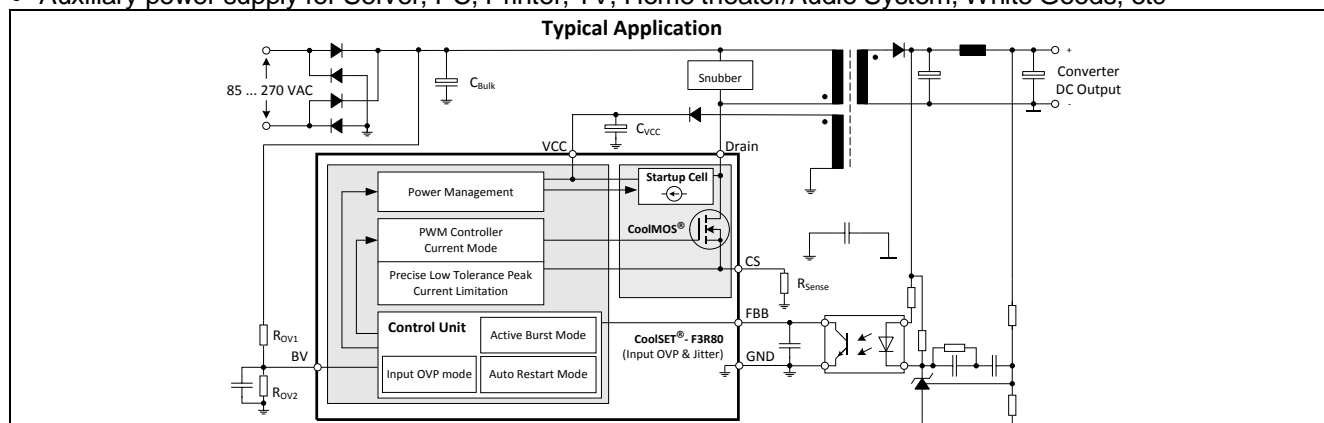
- 800V avalanche rugged CoolMOS™ with Startup Cell
- Active Burst Mode for lowest Standby Power
- Selectable entry and exit burst mode level
- 100kHz internally fixed switching frequency with jittering feature
- Auto Restart Protection for Over load, Open Loop, VCC Under voltage & Over voltage and Over temperature
- Over temperature protection with 50°C hysteresis
- Built-in 10ms Soft Start
- Built-in 20ms and extendable blanking time for short duration peak power
- Propagation delay compensation for both maximum load and burst mode
- Adjustable input OVP
- Overall tolerance of Current Limiting < ±5%
- BiCMOS technology for low power consumption and wide VCC voltage range
- Soft gate drive with 50Ω turn on resistor

### Description

The ICE3AR1580VJZ is a modified version of ICE3ARxx80JZ (CoolSET™-F3R 800V) in DIP-7 package. It adds in the input OVP feature but removes the brownout feature and external protection enable feature. In summary, the ICE3AR1580VJZ is a device running at 100kHz, implemented with input OVP feature, installed with 800V MOSFET with startup cell and housed in DIP-7 package. It provides good voltage margin of MOSFET, lowest standby power, selectable burst level, reduced output ripple during burst mode, robust protection with input OVP feature, accurate maximum power control for both maximum power and burst power, low EMI with frequency jittering and soft gate drive, built-in and flexible protections, etc.

### Applications

- Adapter/Charger
- Blue Ray/DVD player, Set-top Box, Digital Photo Frame
- Auxiliary power supply for Server, PC, Printer, TV, Home theater/Audio System, White Goods, etc



**Figure 1: Typical Application**

Type	Package	Marking	V <sub>DS</sub>	F <sub>osc</sub>	R <sub>DS(on)</sub> <sup>1)</sup>	230VAC ±15% <sup>2)</sup>	85-265 VAC <sup>2)</sup>
ICE3AR1580VJZ	PG-DIP-7	3AR1580VJZ	800V	100kHz	1.5	57W	36W

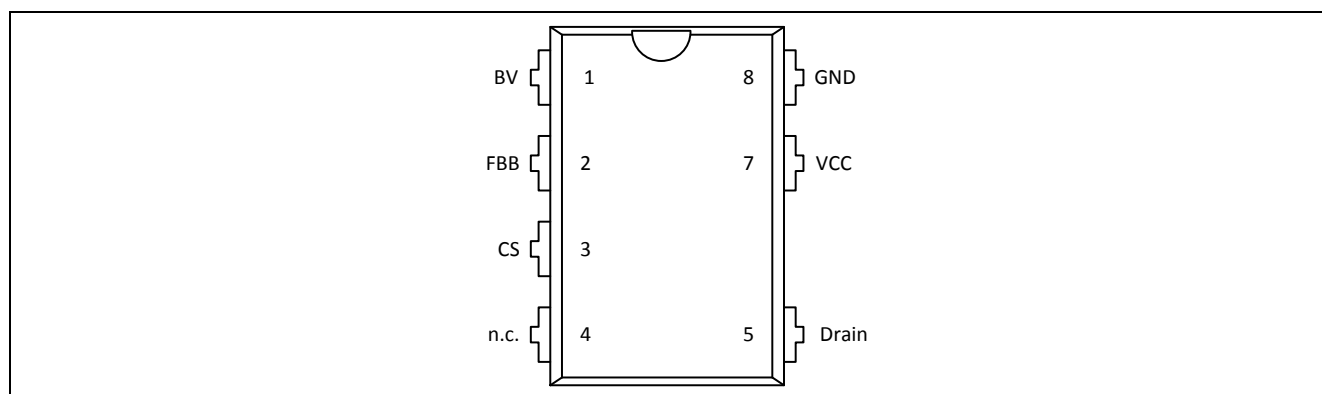
1) typ @ T=25°C

2) Calculated maximum input power rating at T<sub>a</sub>=50°C, T<sub>i</sub>=125°C and without copper area as heat sink.

# 1 Pin Configuration and Functionality

## 1.1 Pin Configuration with PG-DIP-7

Pin	Symbol	Function
1	BV	extended Blanking time & input OVP
2	FBB	Feedback & Burst entry/exit control
3	CS	Current Sense/ 800V CoolMOS™ Source
4	n.c.	not connected
5	Drain	800V CoolMOS™ Drain
6	-	(no pin)
7	VCC	Controller Supply Voltage
8	GND	Controller Ground



**Figure 2: Pin configuration PG-DIP-7(top view)**

## 1.2 Pin Functionality

### **BV (extended Blanking time & input OVP)**

The BV pin combines the functions of input OVP and extendable blanking time for over load protection. The input OVP feature is to stop the switching pulse when the input line voltage is higher than the  $V_{OVP\_ref}$  after the resistor divider (Refer to Figure 3). The extendable blanking time function is to extend the built-in 20 ms blanking time for over load protection by adding an external capacitor to ground.

### **FBB (Feedback & Burst entry control)**

The FBB pin combines the feedback function and the burst entry/exit control. The regulation information is provided by the FBB pin to the internal Protection Unit and the internal PWM-Comparator to control the duty cycle. The FBB-signal is the only control signal in case of light load at the Active Burst Mode. The burst entry/ exit control provides an access to select the entry/exit burst mode level.

### **CS (Current Sense)**

The Current Sense pin senses the voltage developed on the shunt resistor inserted in the source of the integrated CoolMOS™. If CS reaches the internal threshold of the Current Limit Comparator, the Driver output is immediately switched off. Furthermore the current information is provided for the PWM comparator to realize the Current Mode.



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**Pin Configuration and Functionality****Drain (Drain of integrated CoolMOS™)**

Pin Drain is the connection to the Drain of the integrated CoolMOS™.

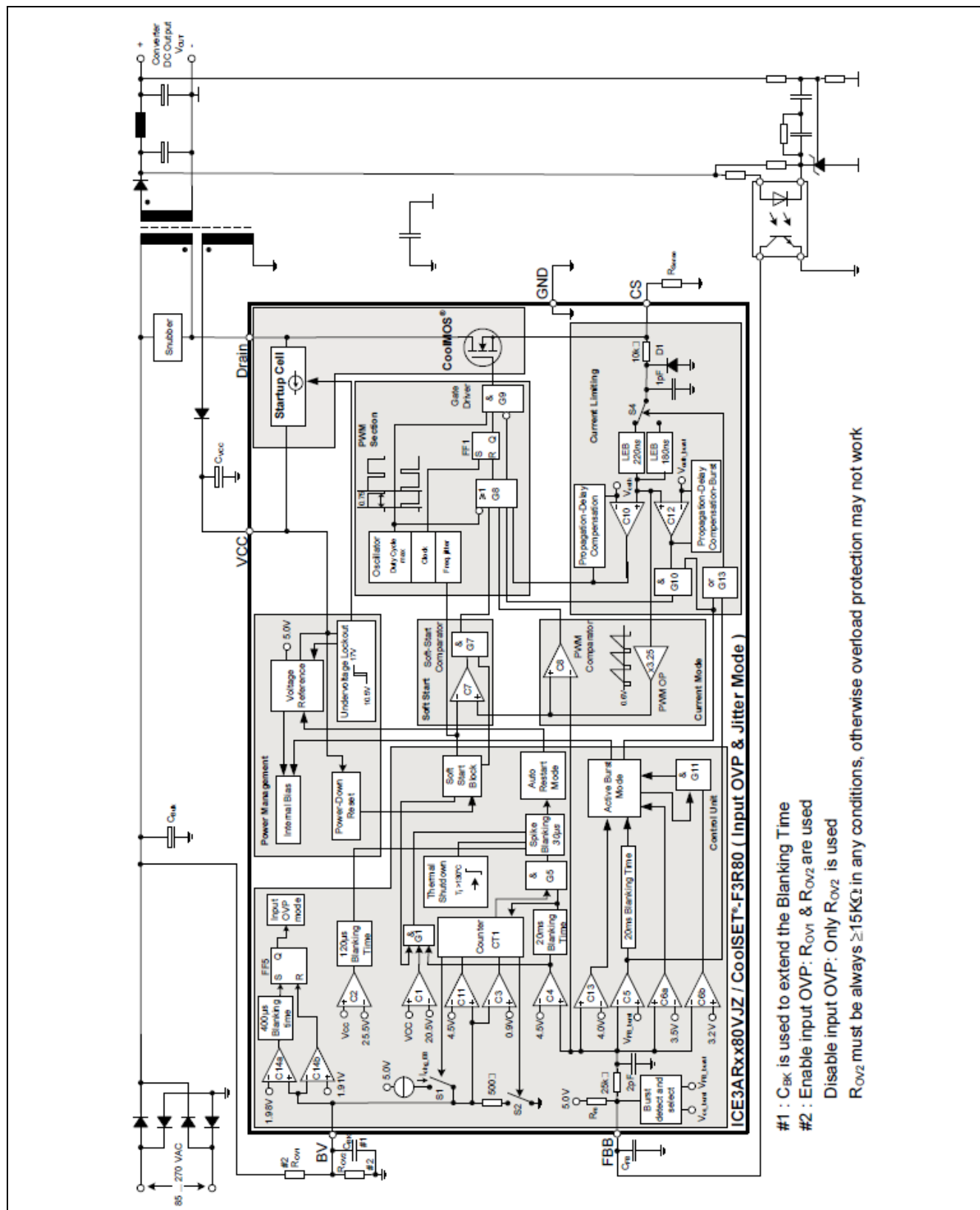
**VCC (Power Supply)**

The VCC pin is the positive supply of the IC. The operating range is between 10.5V and 25V.

**GND (Ground)**

The GND pin is the ground of the controller.

## 2 Representative Block Diagram



**Figure 3: Representative Block Diagram**

### 3 Functional Description

All values which are used in the functional description are typical values. For calculating the worst cases the min/max values which can be found in section 4 Electrical Characteristics have to be considered.

#### 3.1 Introduction

ICE3AR1580VJZ input OVP and jitter 800V version is the modified version of the ICE3ARxx80JZ. It is particular good for high voltage margin low power SMPS application such as white goods, auxiliary power supply for PC and server. The major characteristics are that the IC is developed with 800V CoolMOS™ with start up cell, having adjustable input OVP feature, running at 100kHz switching frequency and packed in DIP-7 package.

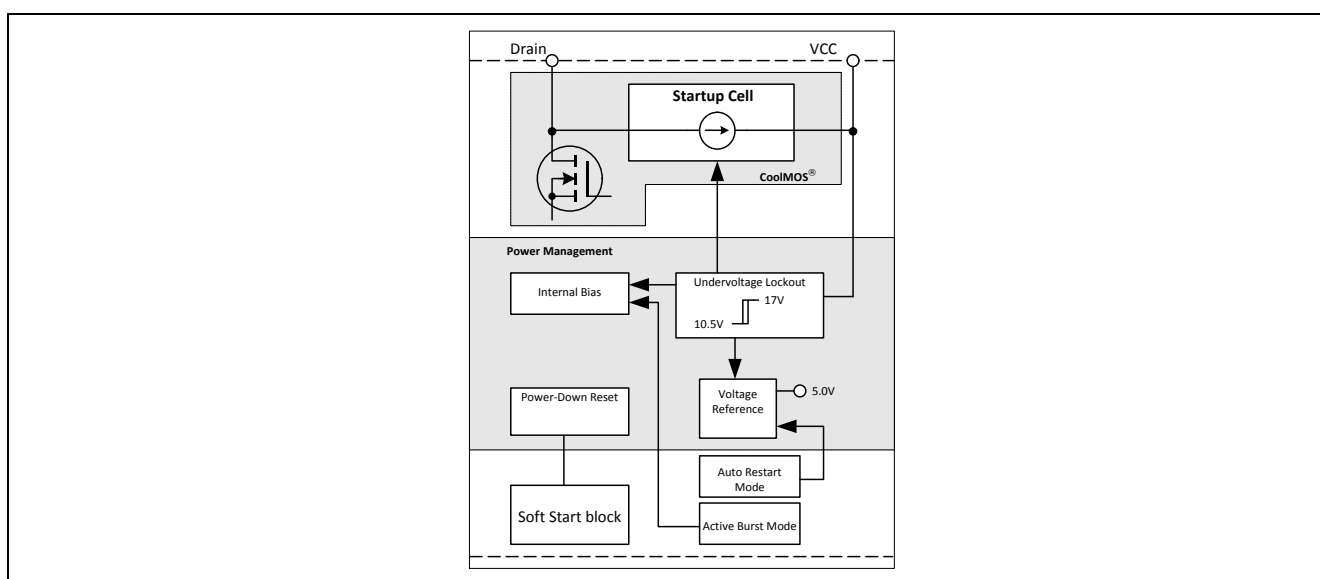
The familiar features are BiCMOS technology to reduce power consumption and increase the  $V_{CC}$  voltage range, cycle by cycle current mode control, built-in 10ms soft start to reduce the stress of switching elements during start up, built-in 20ms and extended blanking time for short period of peak power before entering protection, active burst mode for lowest standby power and propagation delay compensation for close power limit between high line and low line, frequency jittering for low EMI performance, the built-in auto-restart mode protections for open loop, over load,  $V_{CC}$  OVP,  $V_{CC}$  under voltage, etc.

Besides, it also includes narrowing the feedback voltage swing from 0.5V to 0.3V during burst mode so that the output voltage ripple can be reduced by 40%, reduction of the fast voltage fall time of the MOSFET by increasing the soft turn-on time and addition of 50Ω turn-on resistor, faster start up time by optimizing the  $V_{CC}$  capacitor to 10uF and over temperature protection with 50°C hysteresis.

Furthermore, it includes adjustable input OVP to suppress the abnormal input stress to damage the device, selectable entry and exit burst mode for smaller entry/exit power to burst mode or even no burst mode is possible and the propagation delay compensation for burst mode so that the entry/exit burst mode power is close between high line and low line.

In summary, the ICE3AR1580VJZ provides good voltage margin of MOSFET, lowest standby power, flexible burst level, reduced output ripple during burst mode, robust for abnormal input stress with input OVP feature, accurate power limit for both maximum power and burst power, low EMI with frequency jittering and soft gate drive, built-in and flexible protections, etc. Therefore, ICE3AR1580VJZ is a complete solution for the low power SMPS application typically for white goods.

#### 3.2 Power Management



**Figure 4: Power Management**

The Undervoltage Lockout monitors the external supply voltage  $V_{CC}$ . When the SMPS is plugged to the main line the internal Startup Cell is biased and starts to charge the external capacitor  $C_{VCC}$  which is connected to the VCC pin. This

## Functional Description

VCC charge current is controlled to 0.9mA by the Startup Cell. When the  $V_{VCC}$  exceeds the on-threshold  $V_{CCon}=17V$  the bias circuit are switched on. Then the Startup Cell is switched off by the Undervoltage Lockout and therefore no power losses present due to the connection of the Startup Cell to the Drain voltage. To avoid uncontrolled ringing at switch-on, a hysteresis start up voltage is implemented. The switch-off of the controller can only take place when  $V_{VCC}$  falls below 10.5V after normal operation was entered. The maximum current consumption before the controller is activated is about 200 $\mu$ A.

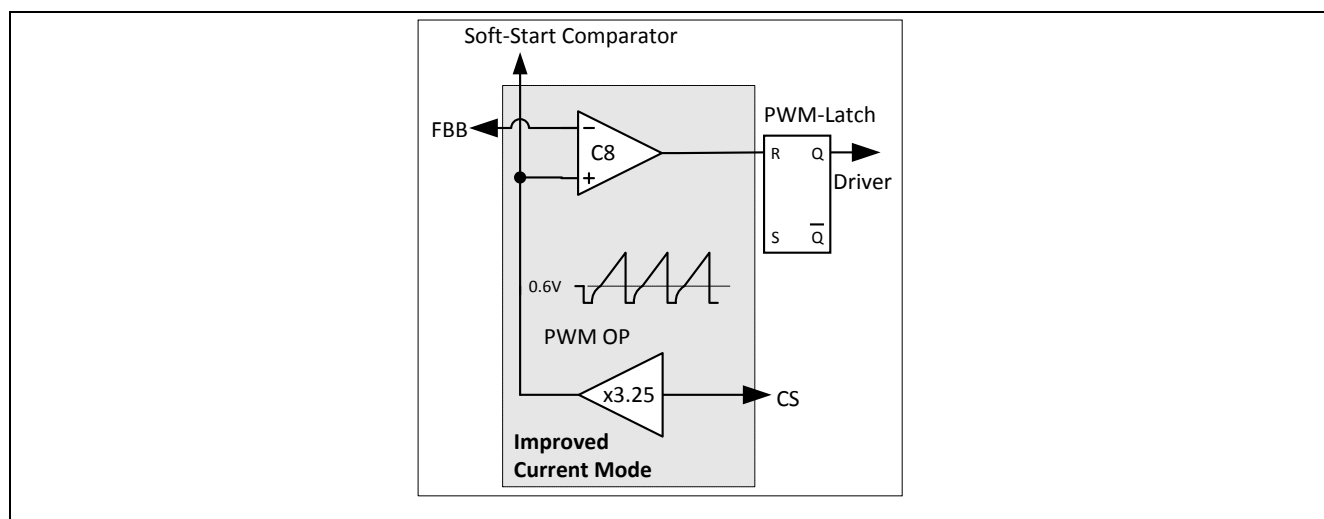
When  $V_{VCC}$  falls below the off-threshold  $V_{CCoff}=10.5V$ , the bias circuit is switched off and the soft start counter is reset. Thus it ensures that at every startup cycle the soft start starts at zero.

The internal bias circuit is switched off if Auto Restart Mode is entered. The current consumption is then reduced to 320 $\mu$ A.

Once the malfunction condition is removed, this block will then turn back on. The recovery from Auto Restart Mode does not require re-cycling the AC line.

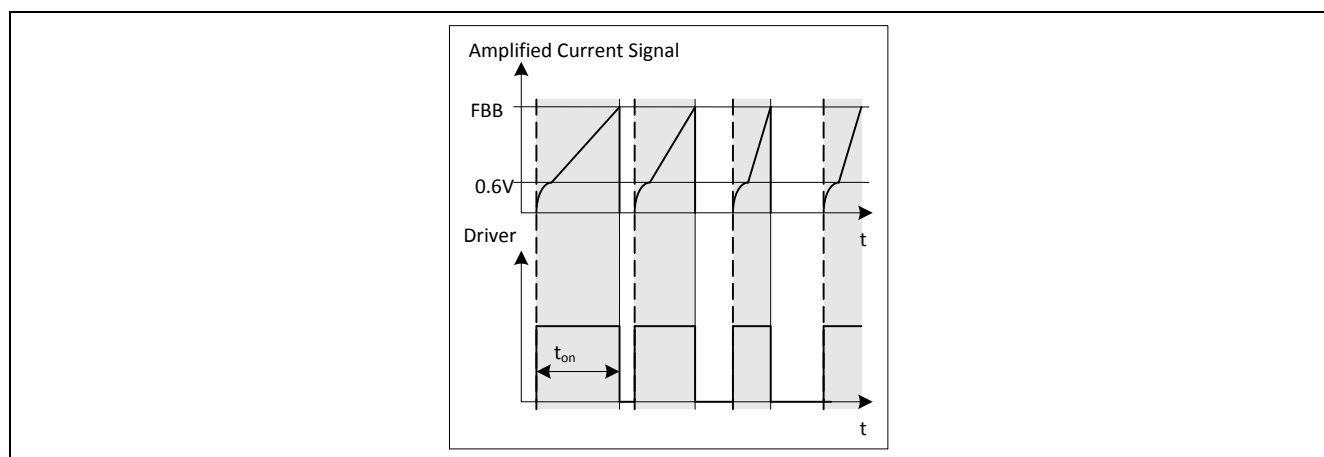
When Active Burst Mode is entered, the internal Bias is switched off most of the time but the Voltage Reference is kept alive in order to reduce the current consumption below 620 $\mu$ A.

### 3.3 Improved Current Mode



**Figure 5: Current Mode**

Current Mode means the duty cycle is controlled by the slope of the primary current. This is done by comparing the FBB signal with the amplified current sense signal.



**Figure 6: Pulse Width Modulation**

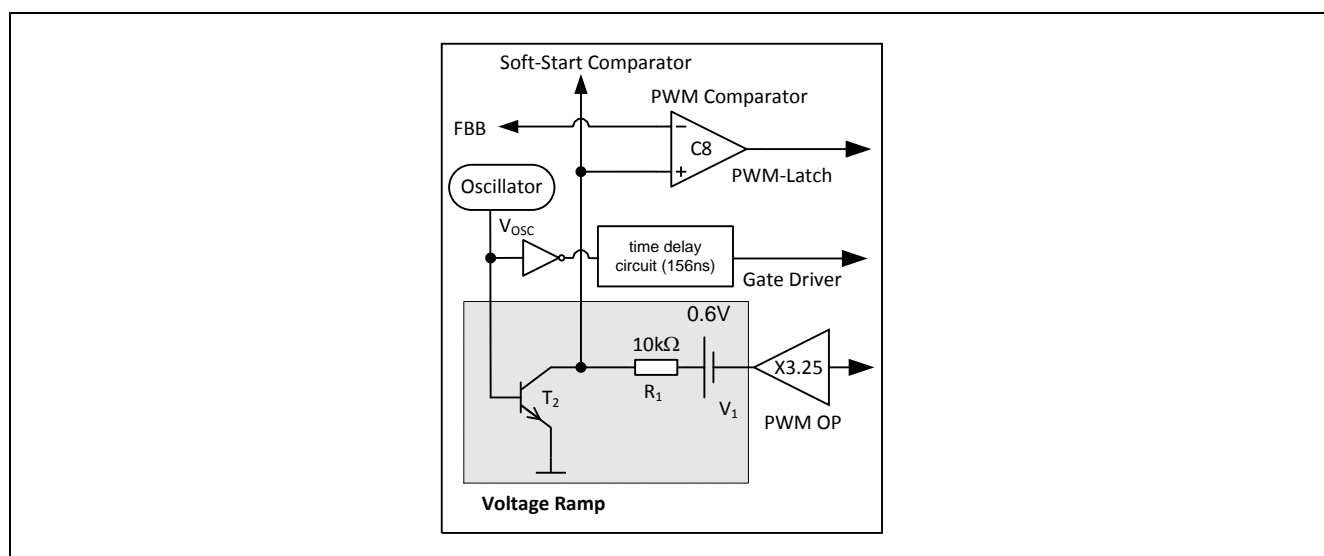
In case the amplified current sense signal exceeds the FBB signal the on-time  $t_{on}$  of the driver is finished by resetting the PWM-Latch (Figure 6).

## Functional Description

The primary current is sensed by the external series resistor  $R_{Sense}$  inserted in the source of the integrated CoolMOS™. By means of Current Mode regulation, the secondary output voltage is insensitive to the line variations. The current waveform slope will change with the line variation, which controls the duty cycle.

The external  $R_{Sense}$  allows an individual adjustment of the maximum source current of the integrated CoolMOS™.

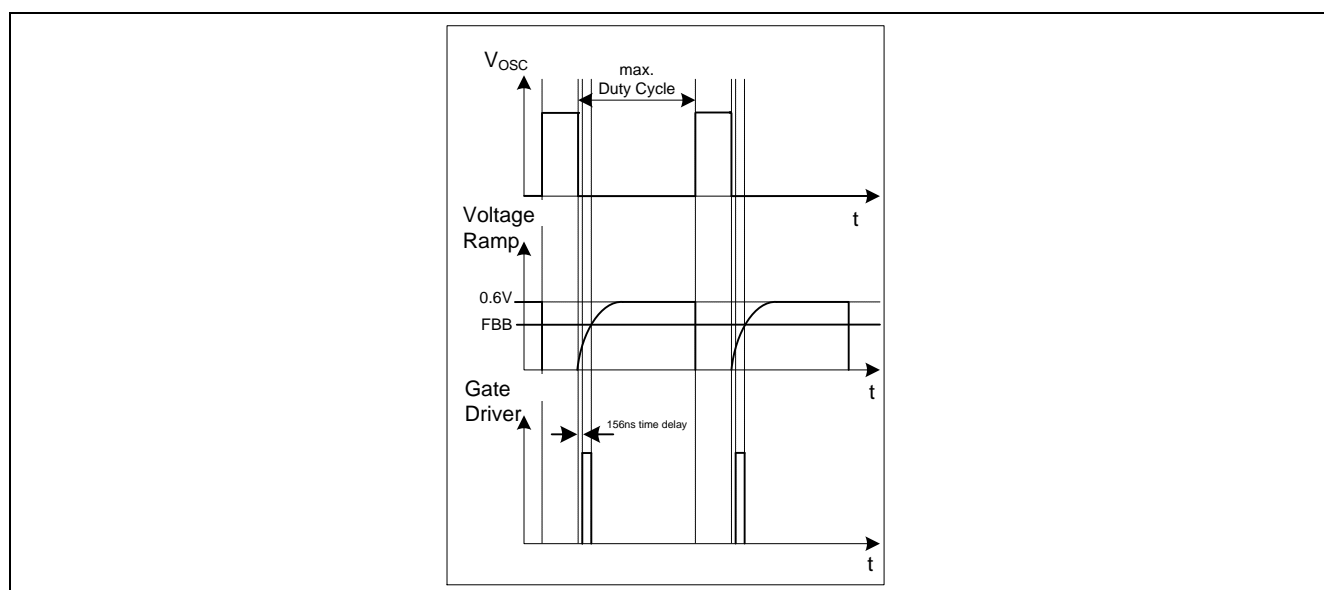
To improve the Current Mode during light load conditions the amplified current ramp of the PWM-OP is superimposed on a voltage ramp, which is built by the switch T2, the voltage source V1 and a resistor R1 (see Figure 7). Every time the oscillator shuts down for maximum duty cycle limitation the switch T2 is closed by  $V_{Osc}$ . When the oscillator triggers the Gate Driver, T2 is opened so that the voltage ramp can start.



**Figure 7: Improved Current Mode**

In case of light load the amplified current ramp is too small to ensure a stable regulation. In that case the Voltage Ramp is a well defined signal for the comparison with the FBB-signal. The duty cycle is then controlled by the slope of the Voltage Ramp.

By means of the time delay circuit which is triggered by the inverted  $V_{Osc}$  signal, the Gate Driver is switched-off until it reaches approximately 156ns delay time (Figure 8). It allows the duty cycle to be reduced continuously till 0% by decreasing  $V_{FBB}$  below that threshold.



**Figure 8: Light Load Conditions**

### 3.3.1 PWM-OP

The input of the PWM-OP is applied over the internal leading edge blanking to the external sense resistor  $R_{Sense}$  connected to pin CS.  $R_{Sense}$  converts the source current into a sense voltage. The sense voltage is amplified with a gain of 3.25 by PWM OP. The output of the PWM-OP is connected to the voltage source  $V_1$ . The voltage ramp with the superimposed amplified current signal is fed into the positive inputs of the PWM-Comparator C8 and the Soft-Start Comparator (Figure 9).

### 3.3.2 PWM-Comparator

The PWM-Comparator compares the sensed current signal of the integrated CoolMOS™ with the feedback signal  $V_{FBB}$  (Figure 9).  $V_{FBB}$  is created by an external optocoupler or external transistor in combination with the internal pull-up resistor  $R_{FB}$  and provides the load information of the feedback circuitry. When the amplified current signal of the integrated CoolMOS™ exceeds the signal  $V_{FBB}$  the PWM-Comparator switches off the Gate Driver.

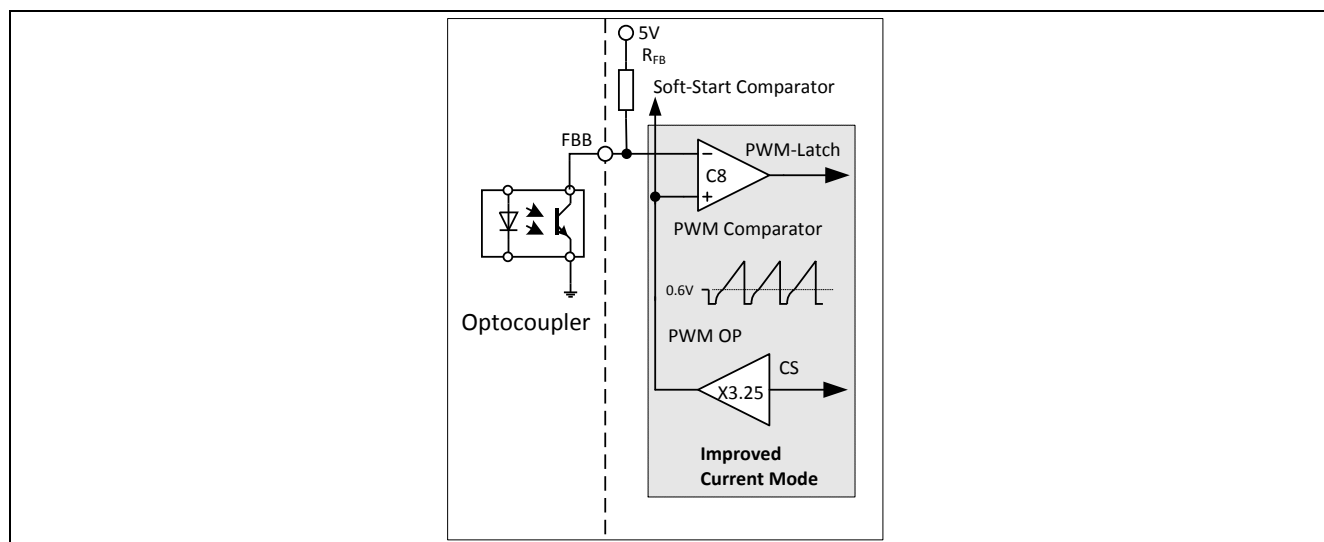


Figure 9: PWM Controlling

## 3.4 Startup Phase

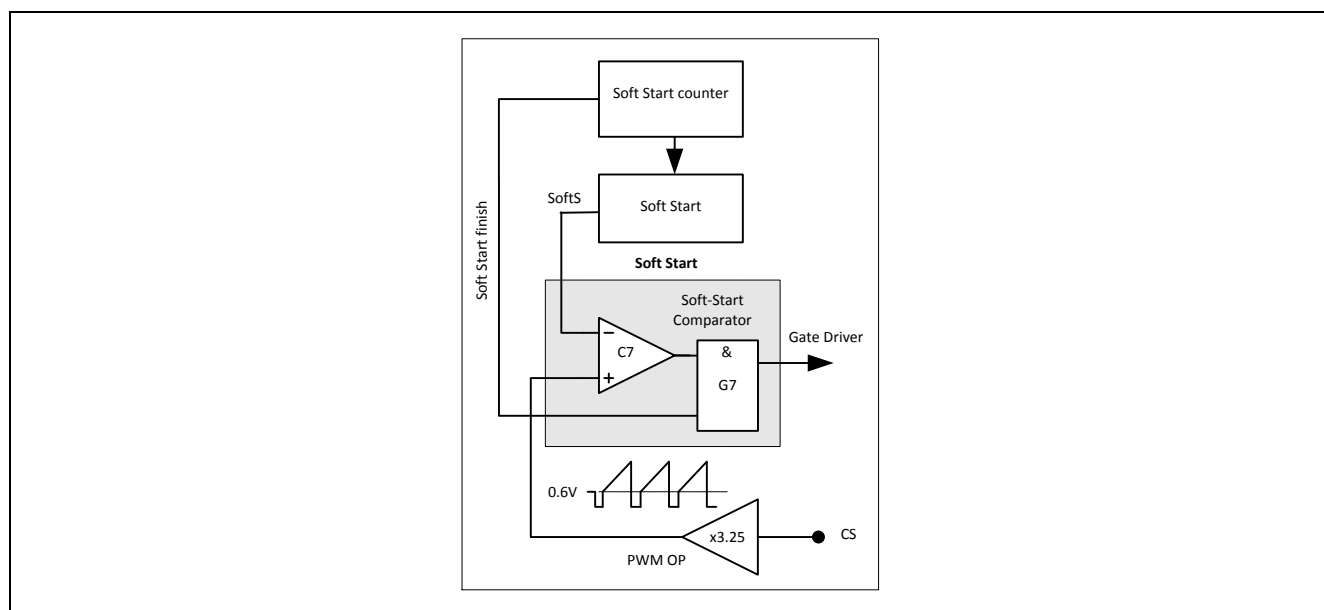
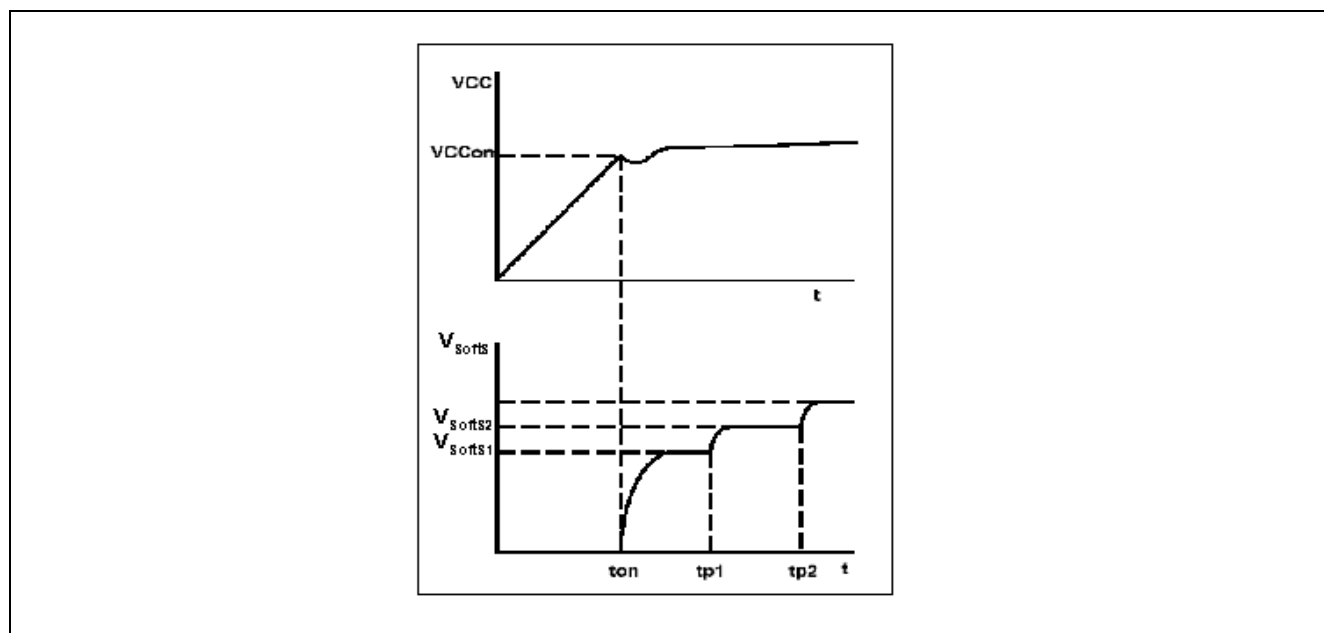


Figure 10: Soft Start

## Functional Description

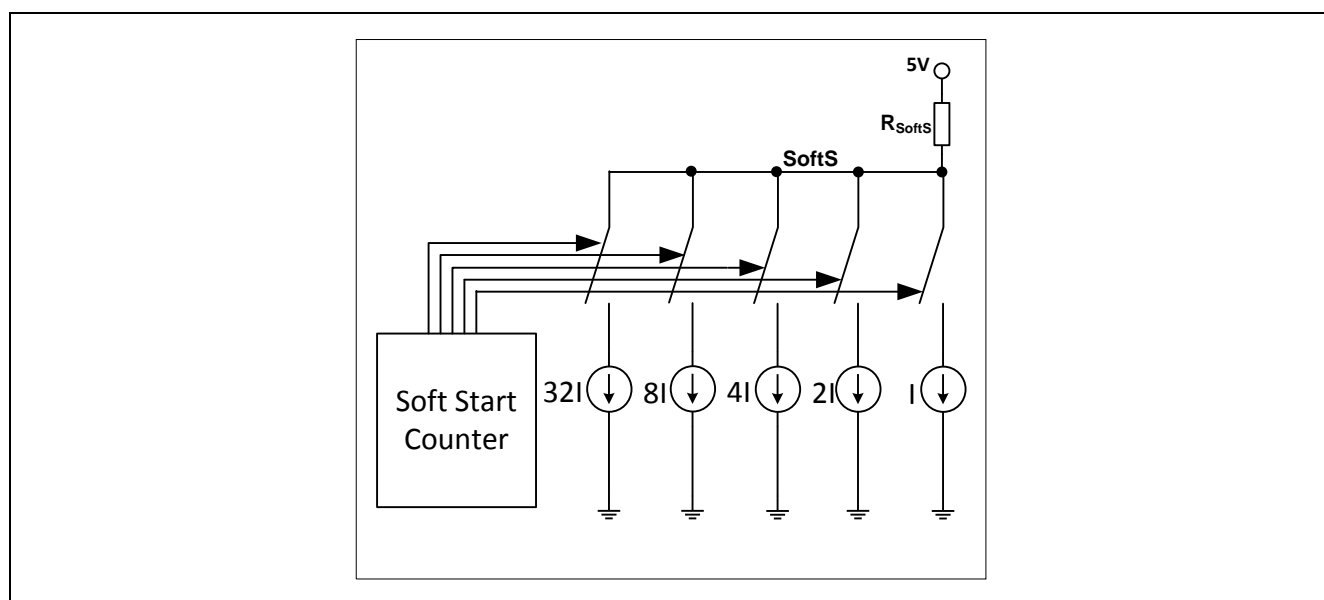
In the Startup Phase, the IC provides a Soft Start period to control the primary current by means of a duty cycle limitation. The Soft Start function is a built-in function and it is controlled by an internal counter.



**Figure 11: Soft Start Phase**

When the  $V_{VCC}$  exceeds the on-threshold voltage, the IC starts the Soft Start mode (Figure 10).

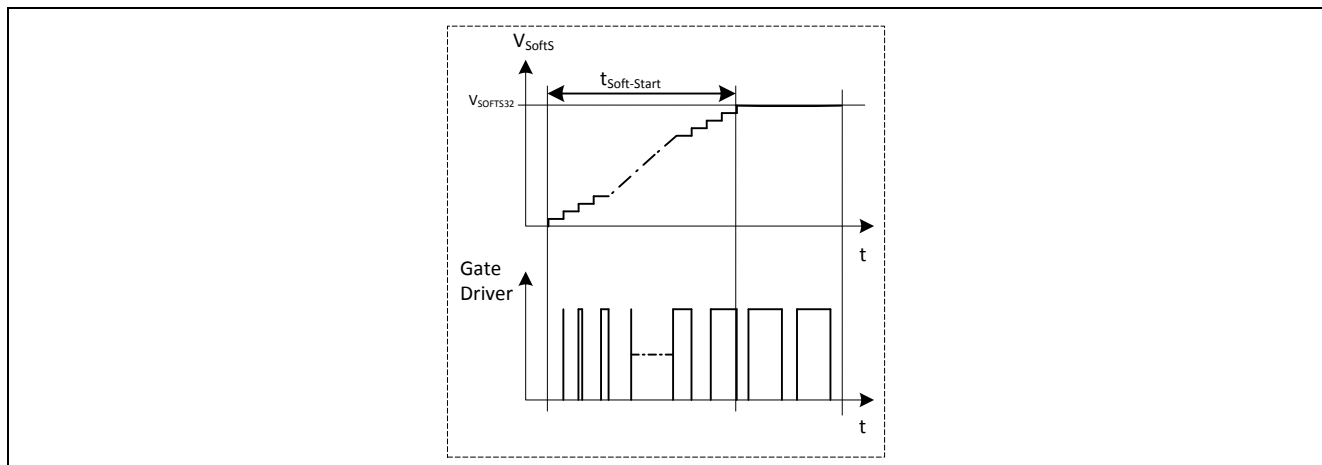
The function is realized by an internal Soft Start resistor, a current sink and a counter. And the amplitude of the current sink is controlled by the counter (Figure 12).



**Figure 12: Soft Start Circuit**

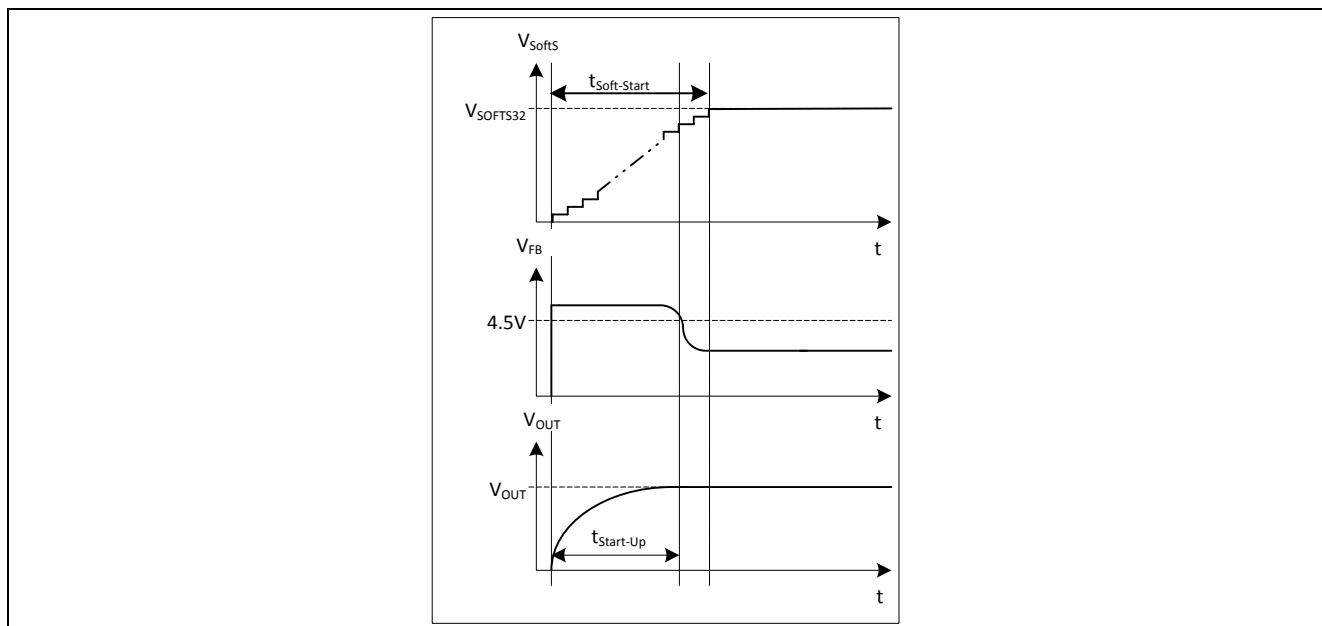
After the IC is switched on, the  $V_{SoftS}$  voltage is controlled such that the voltage is increased step-wisely (32 steps) with the increase of the counts. The Soft Start counter would send a signal to the current sink control in every 300μs such that the current sink decrease gradually and the duty ratio of the gate drive increases gradually. The Soft Start will be finished in 10ms ( $t_{Soft-Start}$ ) after the IC is switched on. At the end of the Soft Start period, the current sink is switched off.

Within the soft start period, the duty cycle is increasing from zero to maximum gradually (see Figure 13).



**Figure 13: Gate drive signal under Soft-Start Phase**

In addition to Start-Up, Soft-Start is also activated at each restart attempt during Auto Restart.



**Figure 14: Start Up Phase**

The Start-Up time  $t_{\text{Start-Up}}$  before the converter output voltage  $V_{\text{OUT}}$  is settled, must be shorter than the Soft-Start Phase  $t_{\text{Soft-Start}}$  (Figure 14). By means of Soft-Start there is an effective minimization of current and voltage stresses on the integrated CoolMOS™, the clamp circuit and the output rectifier and it helps to prevent saturation of the transformer during Start-Up.



### 3.5 PWM Section

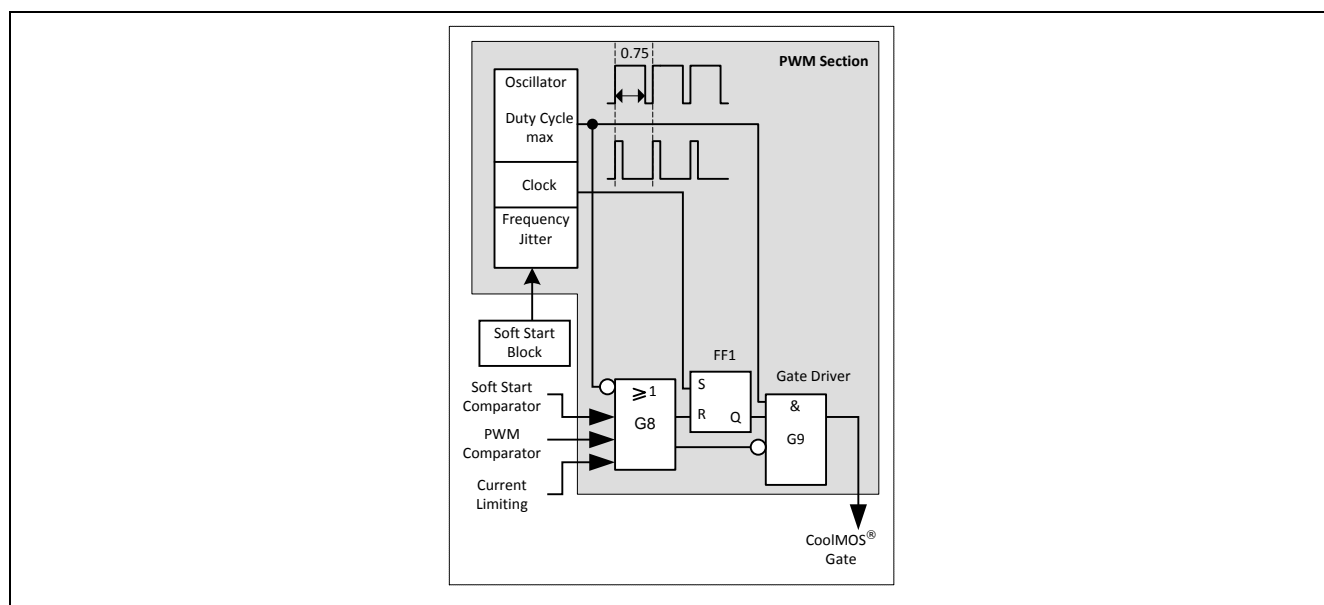


Figure 15: PWM Section Block

#### 3.5.1 Oscillator

The oscillator generates a fixed frequency of 100kHz with frequency jittering of  $\pm 4\%$  (which is  $\pm 4\text{kHz}$ ) at a jittering period of 4ms.

A capacitor, a current source and current sink which determine the frequency are integrated. The charging and discharging current of the implemented oscillator capacitor are internally trimmed in order to achieve a very accurate switching frequency. The ratio of controlled charge to discharge current is adjusted to reach a maximum duty cycle limitation of  $D_{\text{max}}=0.75$ .

Once the Soft Start period is over and when the IC goes into normal operating mode, the switching frequency of the clock is varied by the control signal from the Soft Start block. Then the switching frequency is varied in range of  $100\text{kHz} \pm 4\text{kHz}$  at period of 4ms.

#### 3.5.2 PWM-Latch FF1

The output of the oscillator block provides continuous pulse to the PWM-Latch which turns on/off the integrated CoolMOS™. After the PWM-Latch is set, it is reset by the PWM comparator, the Soft Start comparator or the Current-Limit comparator. When it is in reset mode, the output of the driver is shut down immediately.

#### 3.5.3 Gate Driver

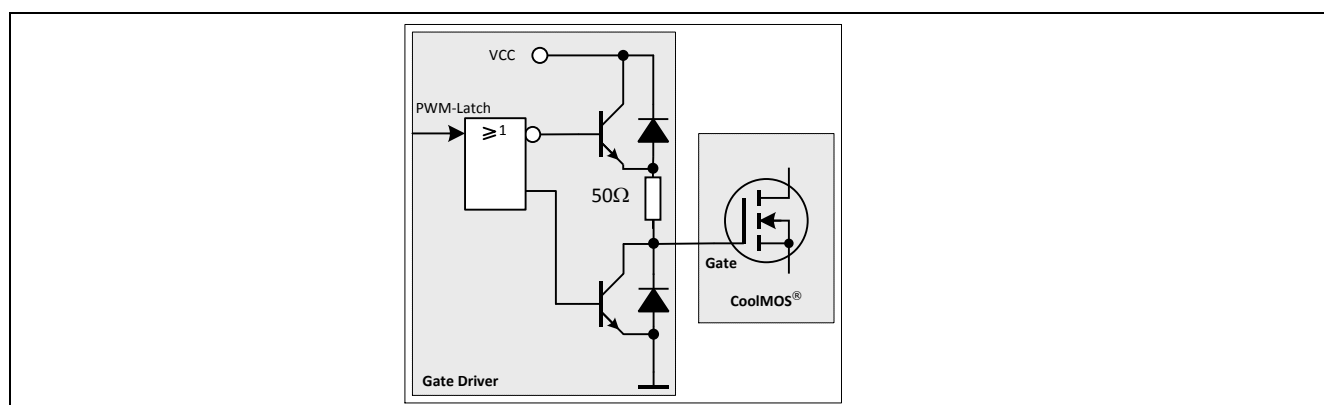


Figure 16: Gate Driver

## Functional Description

The driver-stage is optimized to minimize EMI and to provide high circuit efficiency. This is done by reducing the switch on slope when exceeding the integrated CoolMOS™ threshold. This is achieved by a slope control of the rising edge at the driver's output (Figure 17) and adding a 50Ω gate turn on resistor (Figure 15). Thus the leading switch on spike is minimized.

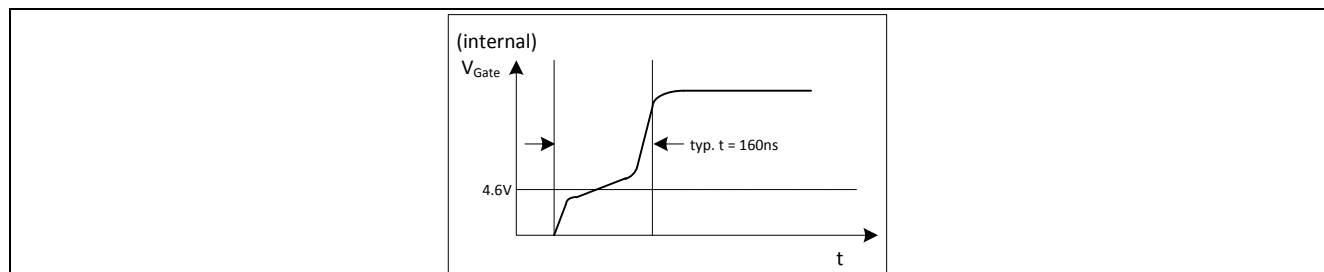


Figure 17: Gate Rising Slope

Furthermore the driver circuit is designed to eliminate cross conduction of the output stage. During power up, when VCC is below the undervoltage lockout threshold  $V_{VCCoff}$ , the output of the Gate Driver is set to low in order to disable power transfer to the secondary side.

## 3.6 Current Limiting

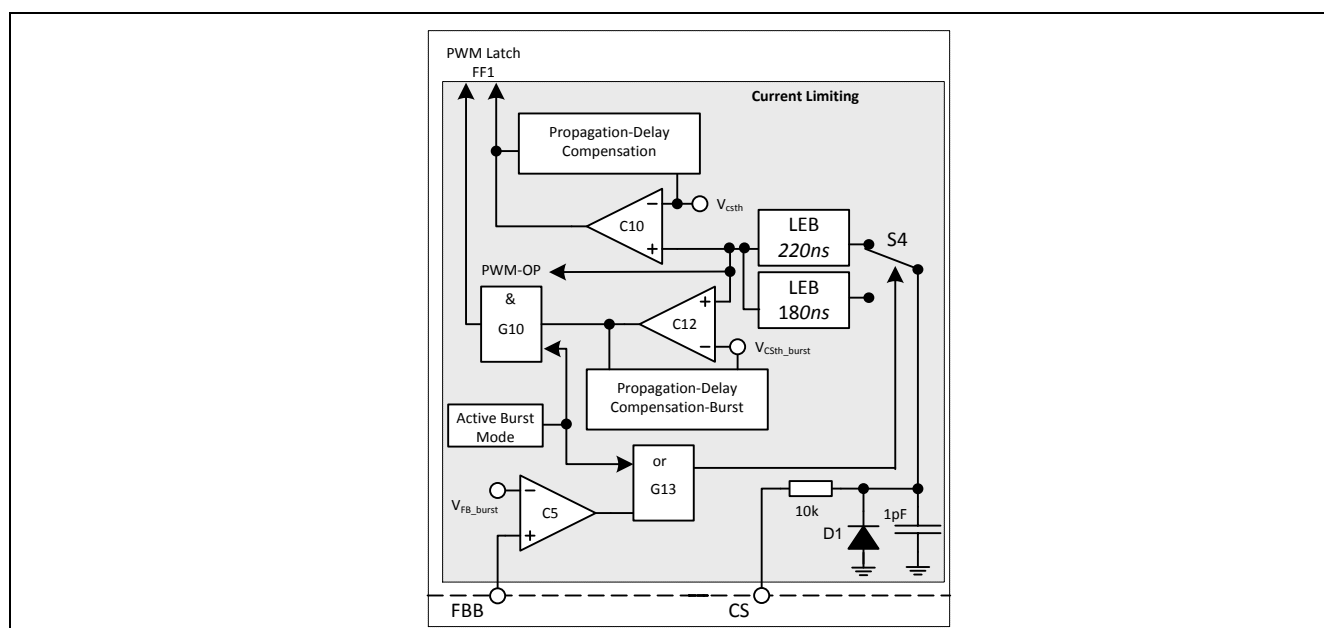


Figure 18: Current Limiting Block

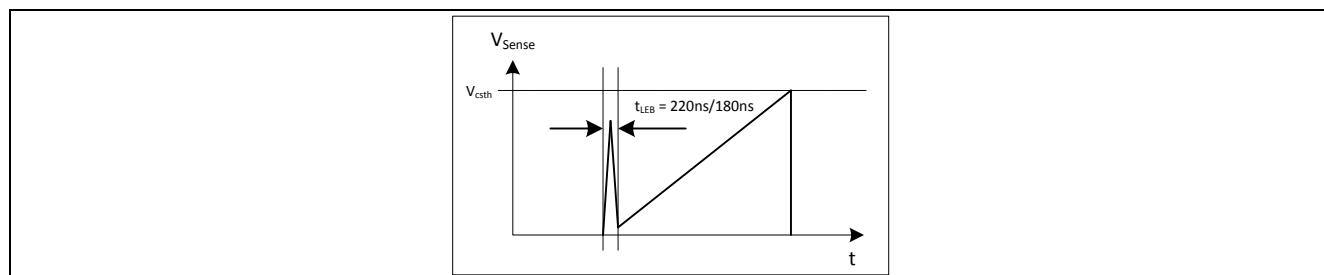
There is a cycle by cycle peak current limiting operation realized by the Current-Limit comparator C10. The source current of the integrated CoolMOS™ is sensed via an external sense resistor  $R_{Sense}$ . By means of  $R_{Sense}$  the source current is transformed to a sense voltage  $V_{Sense}$  which is fed into the pin CS. If the voltage  $V_{Sense}$  exceeds the internal threshold voltage  $V_{csth}$ , the comparator C10 immediately turns off the gate drive by resetting the PWM Latch FF1.

A Propagation Delay Compensation is added to support the immediate shut down of the integrated CoolMOS™ with very short propagation delay. Thus the influence of the AC input voltage on the maximum output power can be reduced to minimal. This compensation applies to both the peak load and burst mode.

In order to prevent the current limit from distortions caused by leading edge spikes, a Leading Edge Blanking (LEB) is integrated in the current sense path for the comparators C10, C12 and the PWM-OP.

The output of comparator C12 is activated by the Gate G10 if Active Burst Mode is entered. When it is activated, the current limiting is reduced to  $V_{csth\_burst}$ . This voltage level determines the maximum power level in Active Burst Mode.

### 3.6.1 Leading Edge Blanking

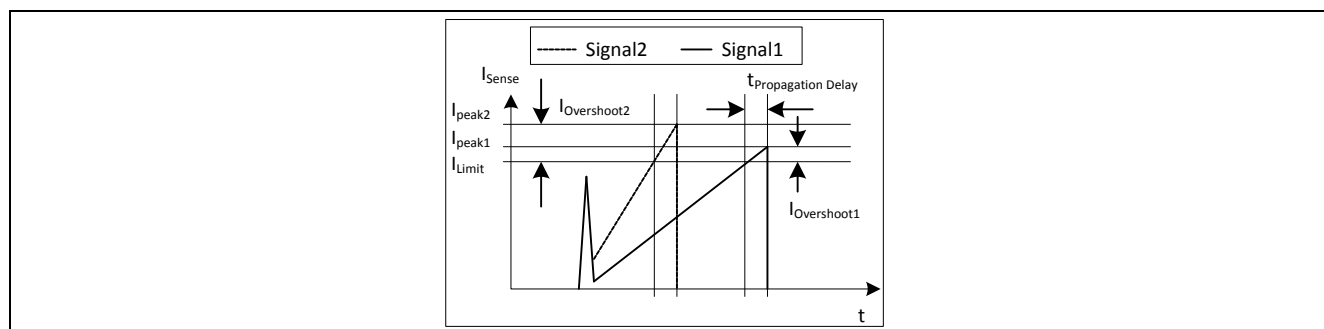


**Figure 19: Leading Edge Blanking**

Whenever the integrated CoolMOS™ is switched on, a leading edge spike is generated due to the primary-side capacitances and reverse recovery time of the secondary-side rectifier. This spike can cause the gate drive to switch off unintentionally. In order to avoid a premature termination of the switching pulse, this spike is blanked out with a time constant of  $t_{LEB} = 220\text{ns}$  for normal load and  $t_{LEB} = 180\text{ns}$  for burst mode.

### 3.6.2 Propagation Delay Compensation (patented)

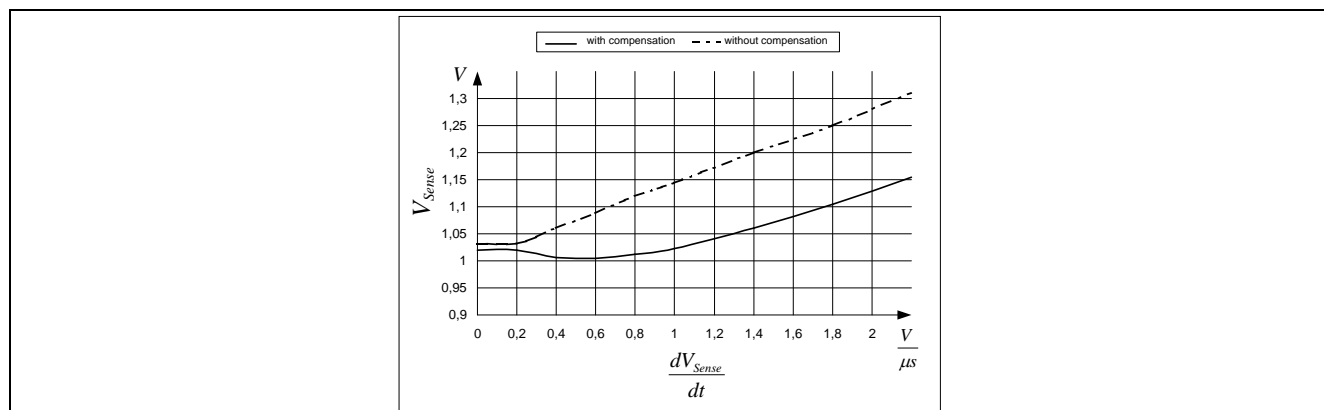
In case of overcurrent detection, there is always propagation delay to switch off the integrated CoolMOS™. An overshoot of the peak current  $I_{peak}$  is induced to the delay, which depends on the ratio of  $dI/dt$  of the peak current (Figure 20).



**Figure 20: Current Limiting**

The overshoot of Signal2 is larger than of Signal1 due to the steeper rising waveform. This change in the slope is depending on the AC input voltage. Propagation Delay Compensation is integrated to reduce the overshoot due to  $dI/dt$  of the rising primary current. Thus the propagation delay time between exceeding the current sense threshold  $V_{csth}$  and the switching off of the integrated CoolMOS™ is compensated over temperature within a wide input range. Current Limiting is then very accurate.

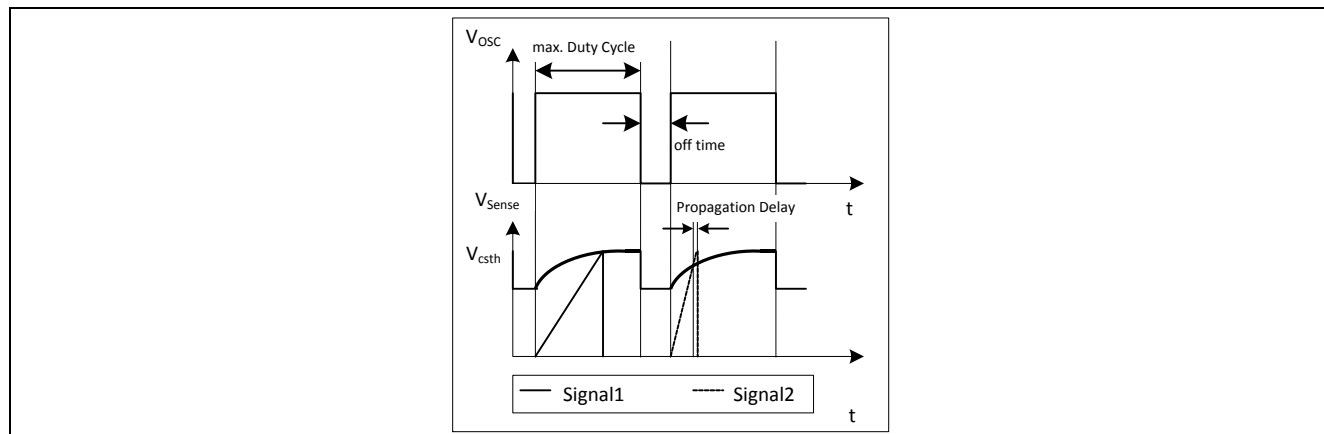
For example,  $I_{peak} = 0.5\text{A}$  with  $R_{Sense} = 2$ . The current sense threshold is set to a static voltage level  $V_{csth} = 1\text{V}$  without Propagation Delay Compensation. A current ramp of  $dI/dt = 0.4\text{A}/\mu\text{s}$ , or  $dV_{Sense}/dt = 0.8\text{V}/\mu\text{s}$ , and a propagation delay time of  $t_{Propagation Delay} = 180\text{ns}$  leads to an  $I_{peak}$  overshoot of 14.4%. With the propagation delay compensation, the overshoot is only around 2% (Figure 21).



**Figure 21: Overcurrent Shutdown**

## Functional Description

The Propagation Delay Compensation is realized by means of a dynamic threshold voltage  $V_{csth}$  (Figure 22). In case of a steeper slope the switch off of the driver is earlier to compensate the delay.



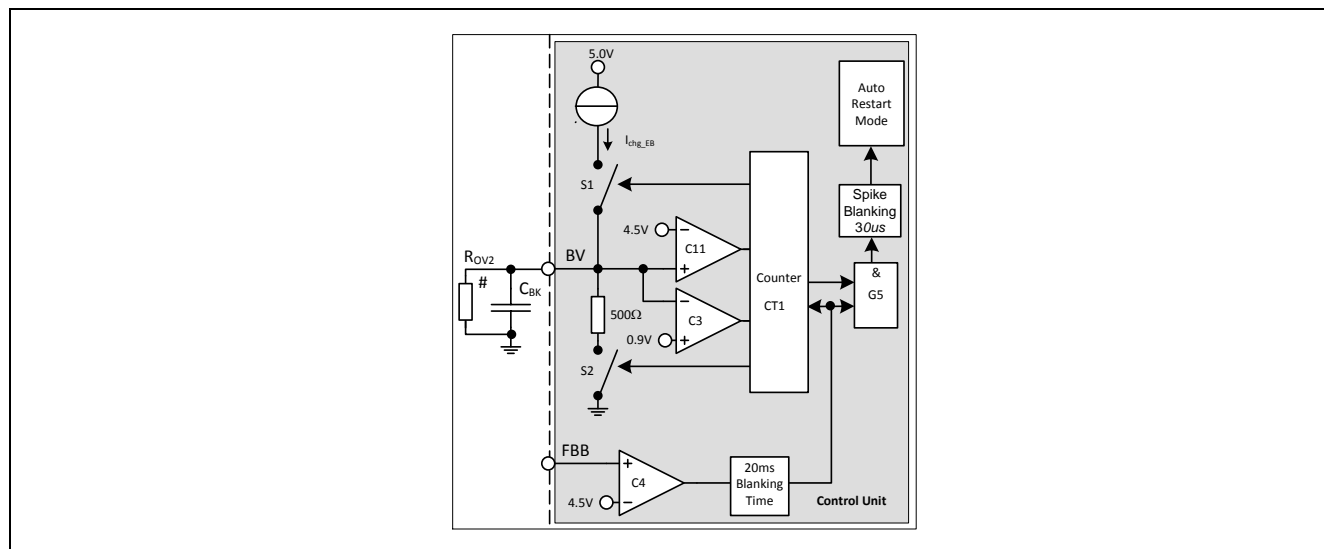
**Figure 22: Dynamic Voltage Threshold  $V_{csth}$**

Similarly, the same concept of propagation delay compensation is also implemented in burst mode with reduced level,  $V_{csth\_burst}$  (Figure 18). With this implementation, the entry and exit burst mode power can be very close between low line and high line input voltage.

### 3.7 Control Unit

The Control Unit contains the functions for Active Burst Mode and Auto Restart Mode. The Active Burst Mode and the Auto Restart Mode both have 20ms internal blanking time. For the over load Auto Restart Mode, the 20ms blanking time can be further extended by adding an external capacitor at BV pin. With the blanking time, the IC avoids entering into those two modes accidentally. That buffer time is very useful for the application which works in short duration of peak power occasionally.

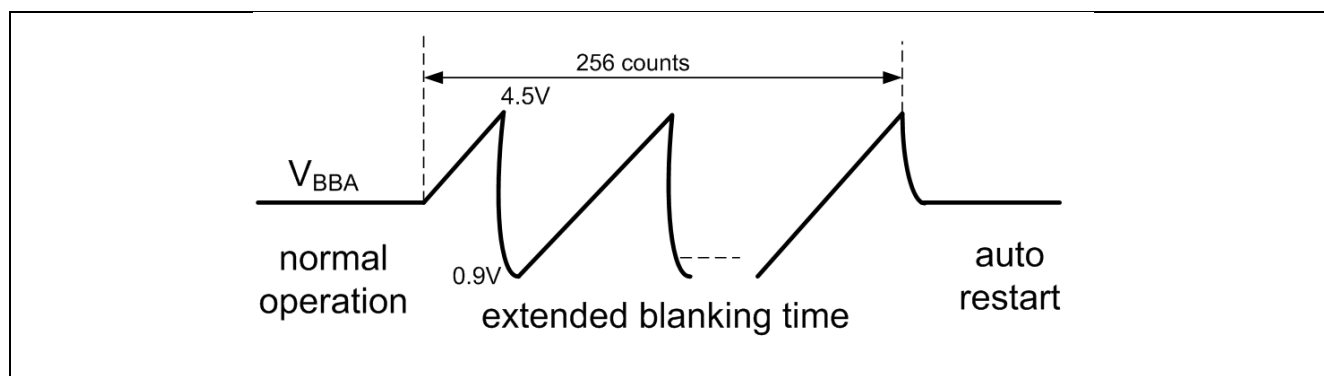
#### 3.7.1 Basic and Extendable Blanking Mode



**Figure 23: Basic and Extendable Blanking Mode**

There are 2 kinds of Blanking mode; basic mode and the extendable mode. The basic mode is a built-in 20ms blanking time while the extendable mode can extend this blanking time by connecting an external capacitor to the BV pin. For the extendable mode, the gate G5 remains blocked even though the 20ms blanking time is reached. After reaching the 20ms blanking time the counter is activated and the switch S1 is turned on to charge the voltage of BV pin by the constant current source,  $I_{chg\_EB}$ . When the voltage of BV pin hits 4.5V, which is sensed by

comparator C11, the counter will increase the counter by 1. Then it switches off the switch S1 and turns on the switch S2. The voltage at BV pin will be discharged through a 500Ω resistor. When the voltage drops to 0.9V which is sensed by comparator C3, the switch S2 will be turned off and the switch S1 will be turned on. Then the constant current  $I_{chg\_EB}$  will charge the  $C_{BK}$  capacitor again. When the voltage at BV hits 4.5V which is sensed by comparator C11, the counter will increase the count to 2. The process repeats until it reaches total count of 256 (Figure 24). Then the counter will release a high output signal. When the AND gate G5 detects both high signals at the inputs, it will activate the 30μs spike blanking circuit and finally the auto-restart mode will be activated.



**Figure 24: Waveform at extended blanking time**

For example, if  $C_{BK}=0.1\mu F$ ,  $I_{chg\_EB}=720\mu A$ ,  $R_{OV2}=15K\Omega$ ,

$$I_{chg\_EB}' = I_{chg\_EB} - (4.5V + 0.9V) / (2 * R_{OV2}) = 540 \mu A$$

$$\text{Extended blanking time} = 256 * (C_{BK} * (4.5V - 0.9V) / I_{chg\_EB}' + C_{BK} * 500 * \ln(4.5/0.9)) = 192ms$$

$$\text{Total blanking time} = 20ms + 192 = 212ms$$

where  $I_{chg\_EB}' = \text{net charging current to } C_{BK}$

*Note: The above calculation does not include the effect of the input OVP circuit where there is extra biasing current flowing from the input. That means the extended blanking time will be shortened with the line voltage change if input OVP circuit is implemented.*

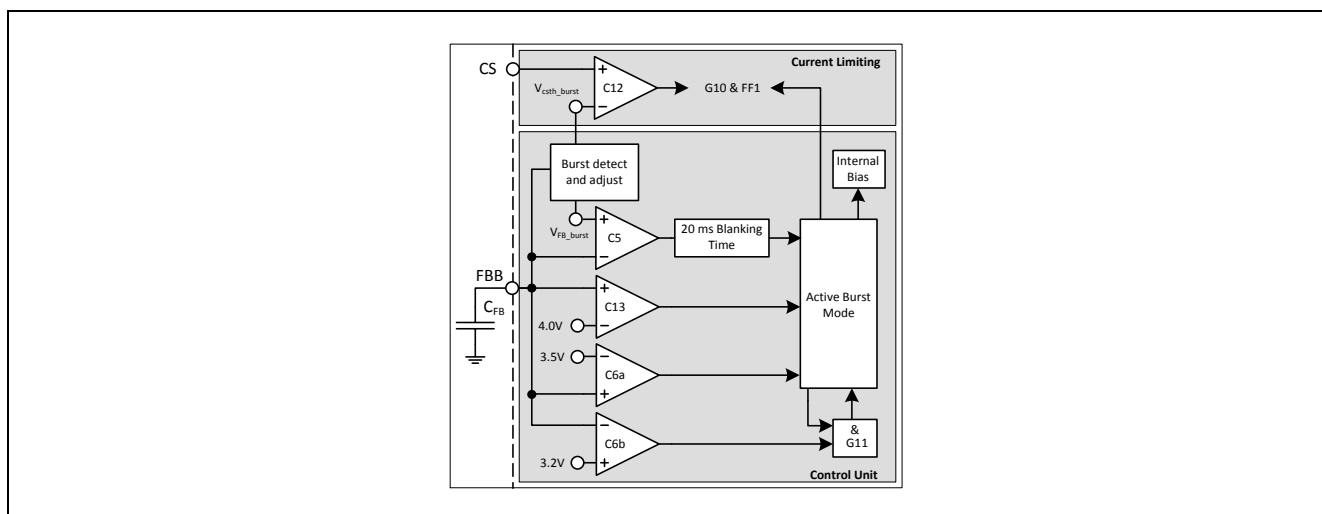
### 3.7.2 Active Burst Mode (patented)

To increase the efficiency of the system at light load, the most effective way is to operate at burst mode. Starting from CoolSET™™ F3, the IC has been employing the active burst mode and it can achieve the lowest standby power. ICE3AR1580VJZ adopts the same concept with some more innovative improvements to the feature. It includes the adjustable entry burst level, close power control between high line and low line and the smaller output ripple during burst mode.

Most of the burst mode design in the market will provide a fixed entry burst mode level which is a ratio to the maximum power of the design. ICE3AR1580VJZ provides a more flexible level which can be selected externally. The provision also includes not entering burst mode.

Propagation delay is the major contributor for the power control variation for DCM flyback converter. It is proved to be effective in the maximum power control. ICE3AR1580VJZ also apply the same concept in the burst mode. Therefore, the entry and exit burst mode power is also finely controlled during burst mode.

The feedback control swing during burst mode will affect the output ripple voltage directly. ICE3AR1580VJZ reduces the swing from 0.5V to 0.3V. Therefore, it would have around 40% improvement for the output ripple.



**Figure 25: Active Burst Mode**

The Active Burst Mode is located in the Control Unit. Figure 24 shows the related components.

### 3.7.2.1 Selectable burst entry level

The burst mode entry level can be selected by changing the different capacitor  $C_{FB}$  at FBB pin. There are 4 levels to be selected with different capacitor which are targeted for 10%, 6.67%, 4.38% and 0% of the maximum input power. At the same time, the exit burst levels are targeted to 20%, 13.3%, 9.6% and 0% of the maximum power accordingly. The corresponding capacitance range is from 6.8nF to 100pF. The below table is the recommended capacitance range for the entry and exit level with the  $C_{FB}$  capacitor.

CFB	Entry level		Exit level	
	% of Pin_max	VFB_burst	% of Pin_max	Vcsth_burst
$\geq 6.8\text{nF}$ (5%,X7R)	10%	1.60V	20%	0.45V
1nF~2.2nF (1%,COG)	6.67%	1.42V	13.3%	0.37V
220pF~470pF (1%,COG)	4.38%	1.27V	9.6%	0.31V
$\leq 100\text{pF}$ (1%,COG)	0%	never	0%	always

The selection is at the 1st 1ms of the UVLO "ON" ( $V_{cc} > 17V$ ) during the 1st start up but it does not detect in the subsequent re-start due to auto-restart protection. In case there is protection triggered such as input OVP before starts up, the detection will be held until the protection is removed. When the  $V_{cc}$  reaches the UVLO "ON" in the 1st start up, the capacitor  $C_{FB}$  at FBB pin is charged by a 5V voltage source through the  $R_{FB}$  resistor. When the voltage at FBB pin hits 4.5V, the FF4 will be set, the switch S9 is turned "ON" and the counter will increase by 1. Then the  $C_{FB}$  is discharged through a 500 $\Omega$  resistor. After reaching 0.5V, the FF4 is reset and the switch S9 is turned "OFF". Then the  $C_{FB}$  capacitor is charged by the 5V voltage source again until it reaches 4.5V. The process repeats until the end of 1ms. Then the detection is ended. After that, the total number of count in the counter is compared and the  $V_{FB\_burst}$  and the  $V_{cs\_burst}$  are selected accordingly (Figure 26)



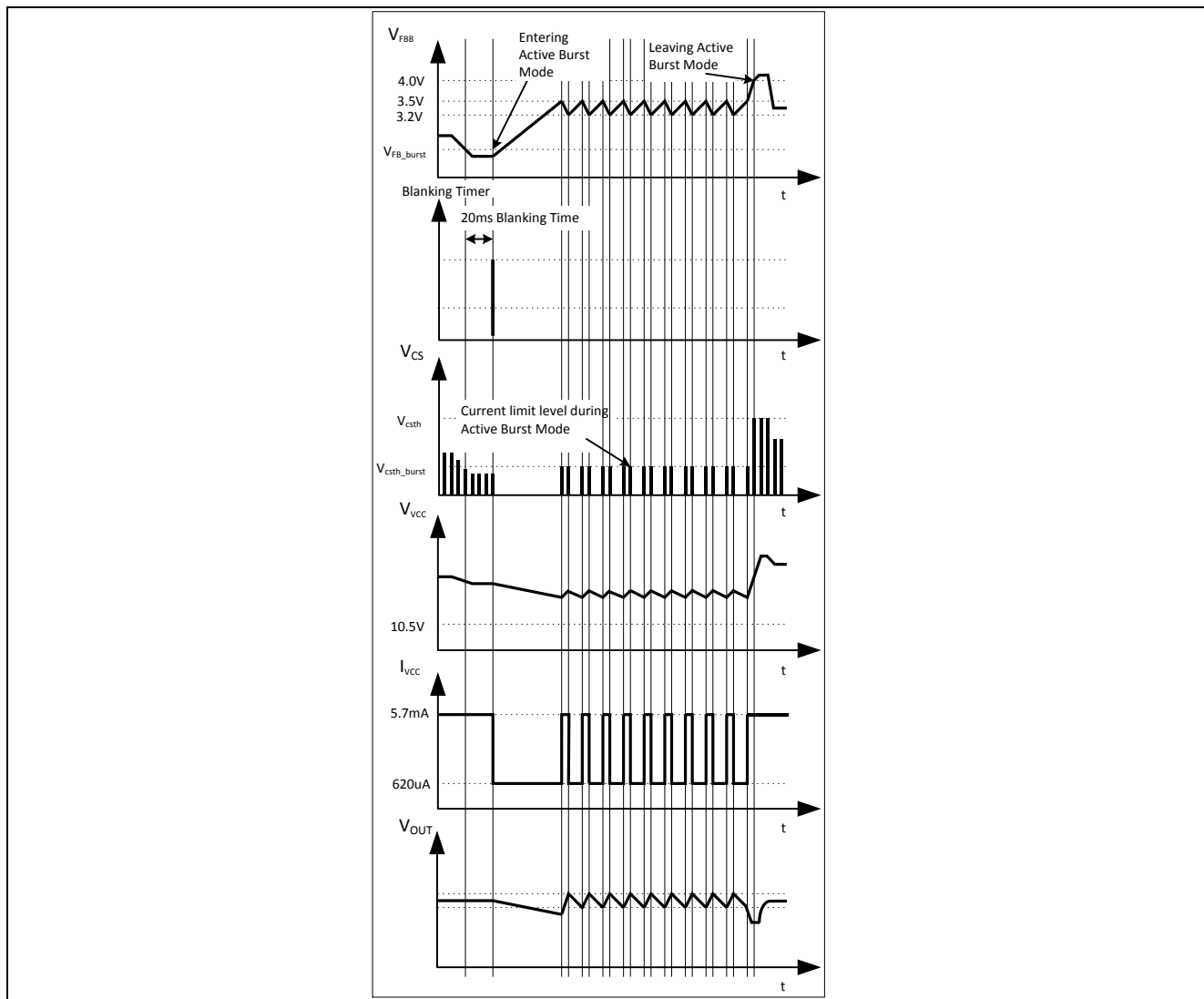


Figure 27: Signals in Active Burst Mode

### 3.7.3 Protection Modes

The IC provides Auto Restart mode as the major protection feature. Auto Restart mode can prevent the SMPS from destructive states. There are 3 kinds of auto restart mode; normal auto restart mode, odd skip auto restart mode and non switch auto restart mode. Odd skip auto restart mode is that there is no detect of fault and no switching pulse for the odd number restart cycle. At the even number of restart cycle the fault detect and soft start switching pulses maintained. If the fault persists, it would continue the auto-restart mode. However, if the fault is removed, it can release to normal operation only at the even number auto restart cycle (Figure 28).

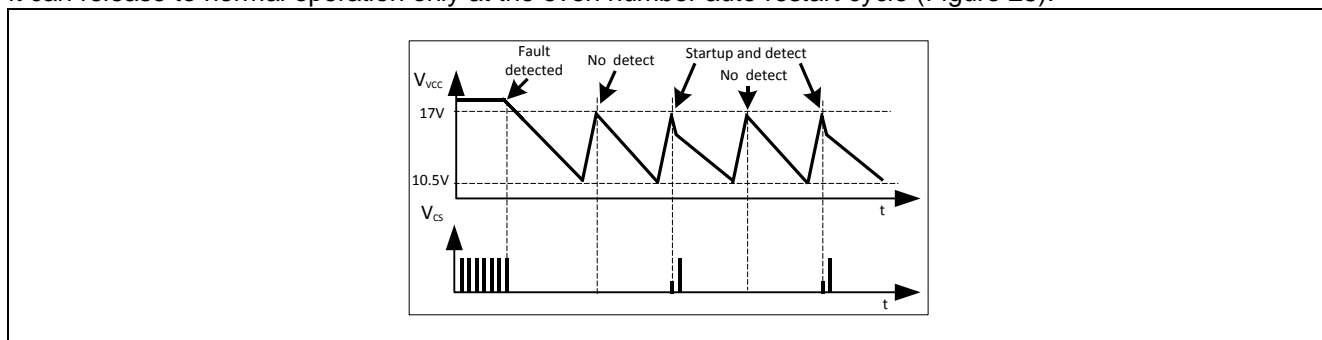
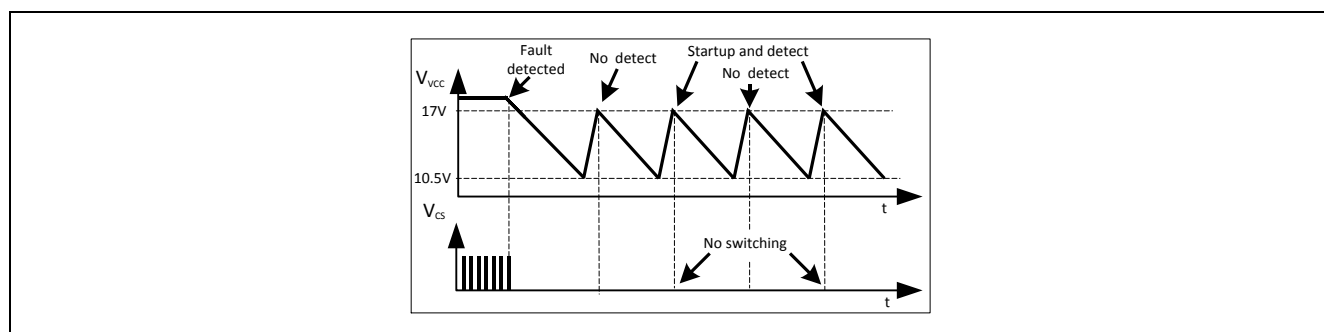


Figure 28: Odd skip auto restart waveform



## Functional Description

Non switch auto restart mode is similar to odd skip auto restart mode except the start up switching pulses are also suppressed at the even number of the restart cycle. The detection of fault still remains at the even number of the restart cycle. When the fault is removed, the IC will resume to normal operation at the even number of the restart cycle (Figure 29).



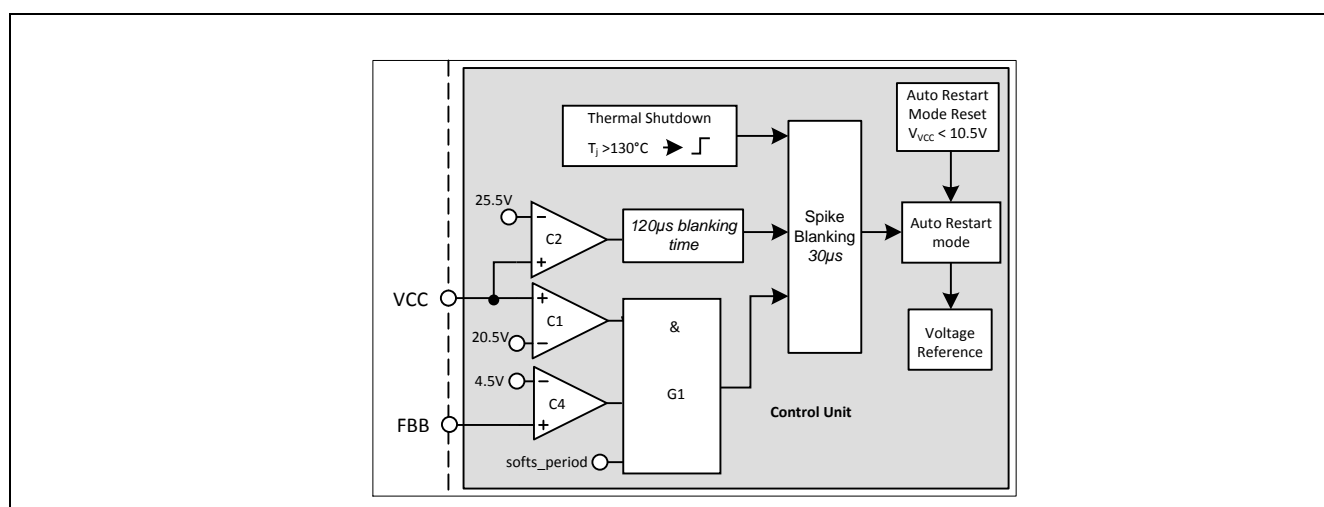
**Figure 29: Non switch auto restart waveform**

The main purpose of the odd skip auto restart is to extend the restart time such that the power loss during auto restart protection can be reduced. This feature is particularly good for smaller Vcc capacitor where the restart time is shorter.

The following table lists the possible system failures and the corresponding protection modes.

VCC Over voltage (1)	Odd skip Auto Restart Mode
VCC Over voltage (2)	Odd skip Auto Restart Mode
Over load	Odd skip Auto Restart Mode
Open Loop	Odd skip Auto Restart Mode
VCC Undervoltage	Normal Auto Restart Mode
Short Optocoupler	Normal Auto Restart Mode
Over temperature	Non switch Auto Restart Mode

### 3.7.3.1 Vcc OVP, OTP and Vcc under voltage



**Figure 30: Vcc OVP and OTP**

There are 2 types of Vcc over voltage protection; Vcc OVP (1) and Vcc OVP (2). The Vcc OVP (1) takes action only during the soft start period. The Vcc OVP (2) takes the action in any conditions.

Vcc OVP (1) condition is when V<sub>VCC</sub> voltage is > 20.5V, V<sub>FBB</sub> voltage is > 4.5V and during soft start period, the IC enters into odd skip Auto Restart Mode. This condition likely happens during start up at open loop fault (Figure 30).

## Functional Description

V<sub>CC</sub> OVP (2) condition is when V<sub>CC</sub> voltage is > 25.5V, the IC enters into odd skip Auto Restart Mode (Figure 30).

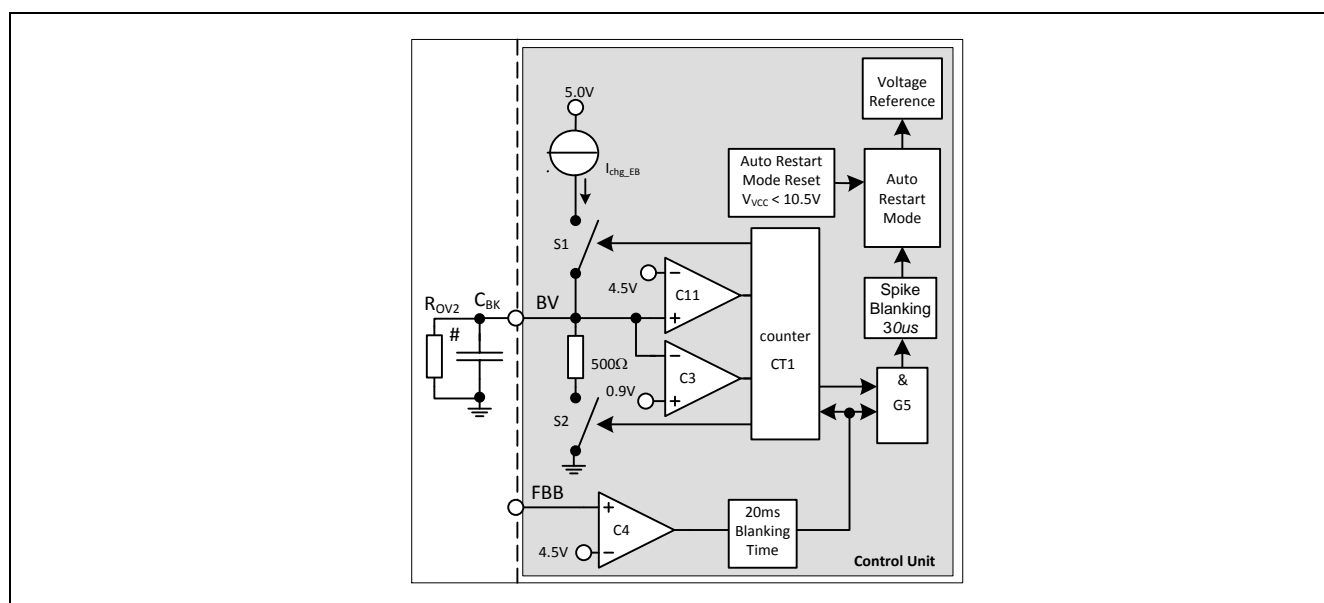
The over temperature protection OTP is sensed inside the controller IC. The Thermal Shutdown block keeps on monitoring the junction temperature of the controller. After detecting a junction temperature higher than 130°C, the IC will enter into the non switch Auto Restart mode. The ICE3AR1580VJZ has also implemented with a 50°C hysteresis. That means the IC can only be recovered when the controller junction temperature is dropped 50°C lower than the over temperature trigger point (Figure 30).

The V<sub>CC</sub> undervoltage and short opto-coupler will go into the normal auto restart mode inherently.

In case of V<sub>CC</sub> undervoltage, the V<sub>CC</sub> voltage drops indefinitely. When it drops below the V<sub>CC</sub> under voltage lock out "OFF" voltage (10.5V), the IC will turn off the IC and the startup cell will turn on again. Then the V<sub>CC</sub> voltage will be charged up to UVLO "ON" voltage (17V) and the IC turns on again provided the startup cell charge up current is not drained by the fault. If the fault is not removed, the V<sub>CC</sub> will continue to drop until it hits UVLO "OFF" voltage and the restart cycle repeats.

Short Optocoupler can lead to V<sub>CC</sub> undervoltage because once the opto-coupler (transistor side) is shorted, the feedback voltage will drop to zero and there will be no switching pulse. Then the V<sub>CC</sub> voltage will drop same as the V<sub>CC</sub> undervoltage.

### 3.7.3.2 Over load, open loop protection



**Figure 31: Over load, open loop protection**

In case of Overload or Open Loop, the FBB exceeds 4.5V which will be observed by comparator C4. Then the built-in blanking time counter starts to count. When it reaches 20ms, the extended blanking time counter CT1 is activated. The switch S2 is turned on and the voltage at the BV pin will be discharged through 500Ω resistor. When it drops to 0.9V, the switch S2 is turned off and the Switch S1 is turned on. Then a constant current source I<sub>chg\_EB</sub> will start to charge up BV pin. When the voltage hits 4.5V which is monitored by comparator C11, the switch S1 is turned off and the count will increase by 1. Then the switch S2 will turn on again and the voltage will drop to 0.9V and rise to 4.5V again. The count will then increase by 1 again. When the total count reaches 256, the counter CT1 will stop and it will release a high output signal. When both the input signals at AND gate G5 is high, the odd skip Auto Restart Mode is activated after the 30μs spike blanking time (Figure 31).

The total blanking time depends on the addition of the built-in and the extended blanking time. If there is no C<sub>BK</sub> capacitor at BV pin, the count will finish within 0.1ms and the equivalent blanking time is just the built-in time of 20ms.

Since the BV pin is a multi-function pin, it would share with different functions. The resistor R<sub>OV2</sub> from input OVP feature application may however affect the extendable blanking time (Figure 31). Thus it should take the R<sub>OV2</sub> into the calculation of the extendable blanking time. For example the extended blanking time may be changed from 181ms to 212ms for 42.2KΩ to 15KΩ R<sub>OV2</sub> resistor. The list below shows one particular C<sub>BK</sub>, R<sub>OV2</sub> vs blanking time.

## Functional Description

$C_{BK}$	$R_{OV2}$	Extended blanking time	Overall blanking time
0.1uF	42.2K $\Omega$	161ms	181ms
0.1uF	39.6K $\Omega$	162ms	182ms
0.1uF	15K $\Omega$	192ms	212ms

Another factor to affect the extended blanking time is the input voltage through the  $R_{OV1}$  and  $R_{OV2}$ . It would, on the contrary, reduce the extended blanking time.

### 3.7.4 Input OVP Mode

When the AC input voltage is out of the designed operating range (e.g. > 300Vac), the voltage at the input bulk capacitor will increase at the same time. If the MOSFET keeps on switching, the drain voltage may be too high and the MOSFET will exceed the maximum voltage rating and causes damages. The input OVP mode is to prevent this phenomenon. The IC will sense the input voltage through the input bulk capacitor to the BV pin by 2 potential divider resistors,  $R_{OV1}$  and  $R_{OV2}$  (Figure 32). During normal operation, the BV pin voltage is lower than  $V_{OVP\_ref}$  (1.98V). The output of C14a is low and the output of G21 is high. Together with UVLO high signal (IC operating) the "S" input of FF5 is low. The "Q" output of FF5 is low and the input OVP mode remains not activated. When there is an input over voltage case, the input bulk capacitor voltage is increased and the BV voltage is increased to larger than  $V_{OVP\_ref}$ . The output of C14a is high and the output of G21 is low. If the OVP persists for 400 $\mu$ s (blanking time) and the UVLO signal is still high, the output of G20 is high. Then the "S" input of FF5 is high and the "Q" output of FF5 is high. The input OVP mode is set. The case of UVLO signal low is not considered as it means the IC is not working.

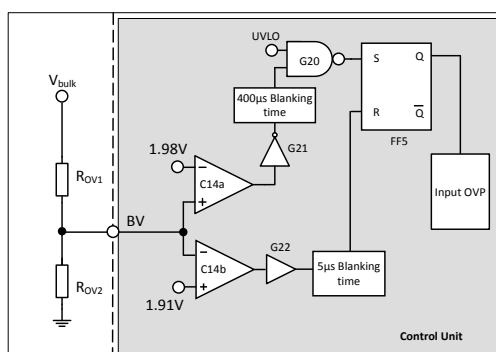


Figure 32: Input OVP detection circuit

Once the system enters the input OVP mode, there will be no switching pulse and the IC keeps on monitoring the BV signal. If the input OVP signal is not reset, there is no switching pulse in each restart cycle (Figure 33).

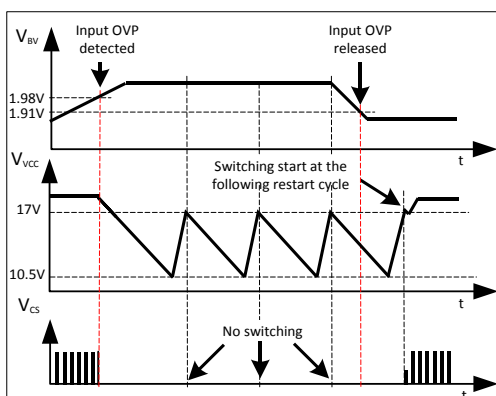


Figure 33: Input OVP mode waveform

## Functional Description

The IC implemented with hysteresis voltage to leave the input OVP protection. The hysteresis voltage at BV pin is  $V_{OVP\_hys}$  (0.07V) and the input OVP reset voltage at BV pin is  $V_{OVP\_ref} - V_{OVP\_hys}$ ; i.e. 1.91V. After the input OVP protection is triggered, the voltage at BV pin needs to drop  $V_{OVP\_hys}$  from  $V_{OVP\_ref}$  before it can be reset.

When the BV voltage drops below 1.91V, the output of C14b and G22 are high (Figure 32). The “R” input of the FF5 is high. Then the “Q” output of FF5 is low. The input OVP is reset. The system will turn on with soft start in the coming restart cycle when  $V_{cc}$  reaches the  $V_{cc}$  “ON” voltage at 17V.

The input OVP feature can also be applied to customer defined protection circuit by pulling up the BV pin to larger than  $V_{OVP\_ref}$ .

The formula to calculate the  $R_{OV1}$  and  $R_{OV2}$  are as below.

*Set  $R_{OV1}$  to a particular value.*

$$R_{OV2} = R_{OV1} \cdot V_{OVP\_ref} / (V_{OVP} - V_{OVP\_ref})$$

The formula to calculate the input OVP reset voltage is as below.

$$V_{OVP\_reset} = (V_{OVP\_ref} - V_{OVP\_hys}) \cdot (R_{OV1} + R_{OV2}) / R_{OV2}$$

where  $V_{OVP}$ : input over voltage;  $V_{OVP\_reset}$ : input over reset voltage;  $V_{OVP\_ref}$ : IC reference voltage for OVP;  $V_{OVP\_hys}$ : IC hysteresis voltage for OVP;  $R_{OV1}$  and  $R_{OV2}$ : resistors divider from input voltage to BV pin.

For example,

$$V_{OVP\_ref} = 1.98V, V_{OVP\_hys} = 0.07V$$

*If input OVP voltage,  $V_{OVP} = 424V_{dc}$  (300Vac),  $R_{OV1} = 9M\Omega$ ,  $R_{OV2} = 42.2K\Omega$*

*Input OVP reset,  $V_{OVP\_reset} = 408V_{dc}$  (289Vac)*

To disable input OVP feature, the BV pin must be connected with a resistor  $R_{OV2} \geq 15K\Omega$  to IC ground and remove  $R_{OV1}$ .

*(Remark:  $R_{OV2}$  must be always  $\geq 15K\Omega$  in all conditions, otherwise overload protection may not work)*

### 3.7.5 Action sequence at BV pin

Since there are 2 functions at the same BV pin; input OVP and extended blanking time, the action of sequence is whichever starts first takes the priority. When the “Extended blanking time” is triggered by OLP and follows with the “Input OVP” triggering, then the OLP will continue to work until it ends. The IC would recheck the signal at BV pin after one skip cycle. If the BV signal exceeds the input OVP threshold, it would go to input OVP mode.

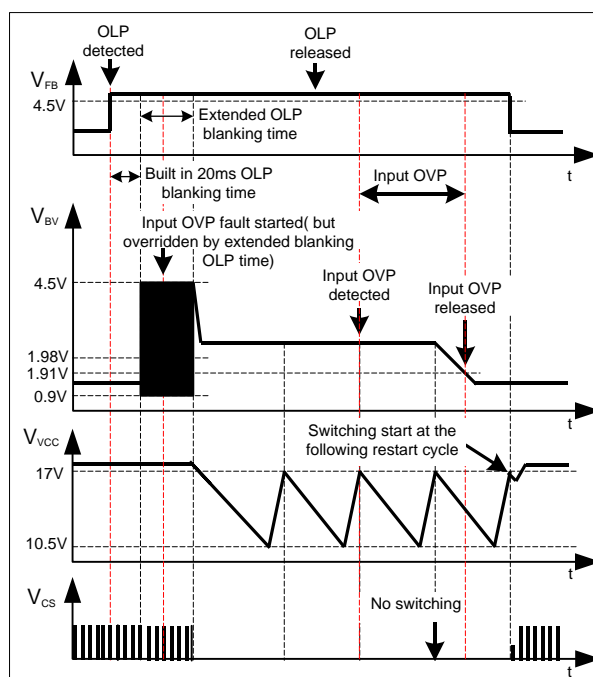


Figure 34: Input OVP during extended blanking time

One typical case happened is that the overload happened first and it follows with the "Input OVP" feature at the 1<sup>st</sup> 20ms blanking time. Since the overload protection is still not triggered at the 1<sup>st</sup> 20ms blanking time period and the extended blanking time is not running, the input OVP mode will trigger right away.

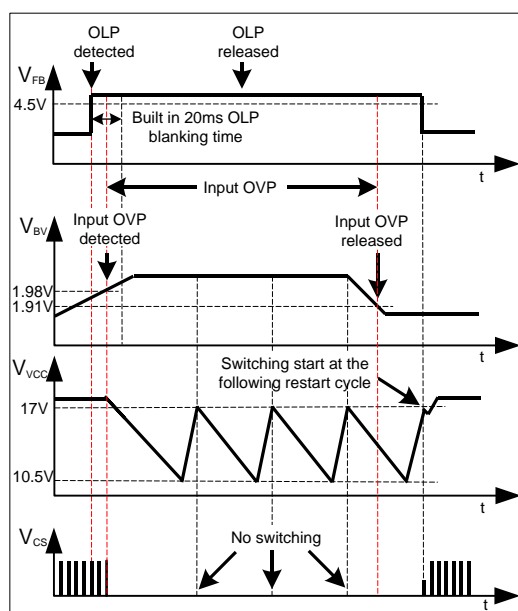


Figure 35: Input OVP during first 20ms blanking time

## 4 Electrical Characteristics

*Note:* All voltages are measured with respect to ground (Pin 8). The voltage levels are valid if other ratings are not violated.

### 4.1 Absolute Maximum Ratings

*Note:* Absolute maximum ratings are defined as ratings, which when being exceeded may lead to destruction of the integrated circuit. For the same reason make sure, that any capacitor that will be connected to pin 7 (VCC) is discharged before assembling the application circuit.  $T_a=25^{\circ}\text{C}$  unless otherwise specified.

Parameter	Symbol	Limit Values		Unit	Remarks
		min.	max.		
Drain Source Voltage	$V_{DS}$	-	800	V	
Pulse drain current, $t_p$ limited by $T_{jmax}$	$I_{D\_Puls}$	-	7.5	A	
Avalanche energy, repetitive $t_{AR}$ limited by max. $T_j=150^{\circ}\text{C}$ <sup>1)</sup>	$E_{AR}$	-	0.07	mJ	
Avalanche current, repetitive $t_{AR}$ limited by max. $T_j=150^{\circ}\text{C}$	$I_{AR}$	-	2.4	A	
VCC Supply Voltage	$V_{VCC}$	-0.3	27	V	
FBB Voltage	$V_{FBB}$	-0.3	5.5	V	
BV Voltage	$V_{BV}$	-0.3	5.5	V	
CS Voltage	$V_{CS}$	-0.3	5.5	V	
Junction Temperature	$T_j$	-40	150	$^{\circ}\text{C}$	Controller & CoolMOS™
Storage Temperature	$T_s$	-55	150	$^{\circ}\text{C}$	
Thermal Resistance Junction -Ambient	$R_{thJA}$	-	96	K/W	
Soldering temperature, wavesoldering only allowed at leads	$T_{sold}$	-	260	$^{\circ}\text{C}$	1.6mm (0.063in.) from case for 10s
ESD Capability (incl. Drain Pin)	$V_{ESD}$	-	2	kV	Human body model <sup>2)</sup>

1) Repetitive avalanche causes additional power losses that can be calculated as  $P_{AV}=E_{AR}*f$

2) According to EIA/JESD22-A114-B (discharging a 100pF capacitor through a 1.5KΩ series resistor)

## 4.2 Operating Range

*Note: Within the operating range the IC operates as described in the functional description.*

Parameter	Symbol	Limit Values		Unit	Remarks
		min.	max.		
VCC Supply Voltage	$V_{VCC}$	$V_{VCCoff}$	25	V	Max value limited due to Vcc OVP
Junction Temperature of Controller	$T_{JCon}$	-40	130	°C	Max value limited due to thermal shut down of controller
Junction Temperature of CoolMOS™	$T_{JCoolMOS}$	-40	150	°C	

## 4.3 Characteristics

### 4.3.1 Supply Section

*Note: The electrical characteristics involve the spread of values within the specified supply voltage and junction temperature range  $T_J$  from  $-40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ . Typical values represent the median values, which are related to  $25^{\circ}\text{C}$ . If not otherwise stated, a supply voltage of  $V_{CC} = 17\text{V}$  is assumed.*

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Start Up Current	$I_{VCCstart}$	-	200	300	$\mu\text{A}$	$V_{VCC} = 16\text{V}$
VCC Charge Current	$I_{VCCcharge1}$	-	-	5.0	mA	$V_{VCC} = 0\text{V}$
	$I_{VCCcharge2}$	0.55	0.9	1.60	mA	$V_{VCC} = 1\text{V}$
	$I_{VCCcharge3}$	0.38	0.7	-	mA	$V_{VCC} = 16\text{V}$
Leakage Current of Start Up Cell and CoolMOS™	$I_{StartLeak}$	-	0.2	50	$\mu\text{A}$	$V_{Drain} = 650\text{V}$ at $T_J = 100^{\circ}\text{C}^{1)}$
Supply Current with Inactive Gate	$I_{VCCsup1}$	-	1.9	3.2	mA	
Supply Current with Active Gate	$I_{VCCsup2}$	-	5.7	7.8	mA	$I_{FBB} = 0\text{A}$
Supply Current in Auto Restart Mode with Inactive Gate	$I_{VCCrestart}$	-	320	-	$\mu\text{A}$	$I_{FBB} = 0\text{A}$
Supply Current in Active Burst Mode with Inactive Gate	$I_{VCCburst1}$	-	620	950	$\mu\text{A}$	$V_{FBB} = 2.5\text{V}$
	$I_{VCCburst2}$	-	620	950	$\mu\text{A}$	$V_{VCC} = 11.5\text{V}$ , $V_{FBB} = 2.5\text{V}$
VCC Turn-On	$V_{VCCon}$	16.0	17.0	18.0	V	
VCC Turn-Off	$V_{VCCoff}$	9.8	10.5	11.2	V	
VCC Turn-On/Off Hysteresis	$V_{VCChys}$	-	6.5	-	V	

1) The parameter is not subjected to production test - verified by design/characterization

### 4.3.2 Internal Voltage Reference

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Trimmed Reference Voltage	$V_{REF}$	4.90	5.00	5.10	V	measured at pin FBB $I_{FBB} = 0$

### 4.3.3 PWM Section

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Fixed Oscillator Frequency	$f_{OSC1}$	87	100	113	kHz	
	$f_{OSC2}$	90	100	108	kHz	$T_j = 25^\circ\text{C}$
Frequency Jittering Range	$f_{jitter}$	-	$\pm 4.0$	-	kHz	$T_j = 25^\circ\text{C}$
Frequency Jittering period	$T_{jitter}$	-	4.0	-	ms	$T_j = 25^\circ\text{C}$
Max. Duty Cycle	$D_{max}$	0.70	0.75	0.80		
Min. Duty Cycle	$D_{min}$	0	-	-		$V_{FBB} < 0.3\text{V}$
PWM-OP Gain	$A_V$	3.05	3.25	3.45		
Voltage Ramp Offset	$V_{Offset-Ramp}$	-	0.60	-	V	
$V_{FBB}$ Operating Range Min Level	$V_{FBmin}$	-	0.7	-	V	
$V_{FBB}$ Operating Range Max level	$V_{FBmax}$	-	-	4.3	V	CS=1V, limited by Comparator C4 <sup>1)</sup>
FBB Pull-Up Resistor	$R_{FB}$	9.0	15.4	23.0	k $\Omega$	

1) The parameter is not subjected to production test - verified by design/characterization

### 4.3.4 Soft Start time

Parameter	Symbol	Limit Values			Unit	Test Condition
		min.	typ.	max.		
Soft Start time	$t_{SS}$	-	10	-	ms	



### 4.3.5 Control Unit

Parameter		Symbol	Limit Values			Unit	Test Condition
			min.	typ.	max.		
Input OVP reference voltage for comparator C14a		$V_{OVP\_ref}$	1.90	1.98	2.06	V	$T_j = 25^\circ\text{C}$
Input OVP hysteresis C14b		$V_{OVP\_hys}$		0.07		V	$T_j = 25^\circ\text{C}$
Blanking time voltage lower limit for Comparator C3		$V_{BKC3}$	0.80	0.90	1.00	V	
Blanking time voltage upper limit for Comparator C11		$V_{BKC11}$	4.28	4.50	4.72	V	
Over Load Limit for Comparator C4		$V_{FBC4}$	4.28	4.50	4.72	V	
Entry Burst select High level for Comparator C19		$V_{FBC19}$	4.28	4.50	4.72	V	
Entry Burst select Low level for Comparator C20		$V_{FBC20}$	0.40	0.50	0.60	V	
Active Burst Mode Entry Level for Comparator C5	10% $P_{in\_max}$	$V_{FB\_burst1}$	1.51	1.60	1.69	V	< 7 counts
	6.67% $P_{in\_max}$	$V_{FB\_burst2}$	1.34	1.42	1.50	V	8 ~ 39 counts
	4.38% $P_{in\_max}$	$V_{FB\_burst3}$	1.20	1.27	1.34	V	40 ~ 191 counts
Active Burst Mode High Level for Comparator C6a		$V_{FBC6a}$	3.35	3.50	3.65	V	In Active Burst Mode
Active Burst Mode Low Level for Comparator C6b		$V_{FBC6b}$	3.06	3.20	3.34	V	
Active Burst Mode Level for Comparator C13		$V_{FBC13}$	3.85	4.00	4.15	V	
Overvoltage Detection Limit for Comparator C1		$V_{VCCOV1}$	19.5	20.5	21.5	V	$V_{FBB} = 5\text{V}$ , during soft start
Overvoltage Detection Limit for Comparator C2		$V_{VCCOV2}$	25.0	25.5	26.3	V	
Charging current for extended blanking time		$I_{chg\_EB}$	460	720	864	$\mu\text{A}$	
Thermal Shutdown <sup>1)</sup>		$T_{jSD}$	130	140	150	$^\circ\text{C}$	Controller
Hysteresis for thermal Shutdown <sup>1)</sup>		$T_{jSD\_hys}$	-	50	-	$^\circ\text{C}$	
Built-in Blanking Time for Overload Protection or enter Active Burst Mode		$t_{\text{BK}}$	-	20	-	ms	
Timer for entry burst select		$t_{EBS}$	-	1	-	ms	
Spike Blanking Time for Auto-Restart Protection		$t_{\text{Spike}}$	-	30	-	$\mu\text{s}$	

1) The parameter is not subjected to production test - verified by design/characterization. The thermal shutdown temperature refers to the junction temperature of the controller.

**Note:** The trend of all the voltage levels in the Control Unit is the same regarding the deviation except  $V_{VCCOV1}$  and  $V_{VCCPD}$

#### 4.3.6 Current Limiting

Parameter		Symbol	Limit Values			Unit	Test Condition
			min.	typ.	max.		
Peak Current Limitation (incl. Propagation Delay)		$V_{csth}$	0.98	1.06	1.13	V	$dV_{sense}/dt = 0.6V/\mu s$ (Figure 21)
Peak Current Limitation during Active Burst Mode	20% $P_{in\_max}$	$V_{csth\_burst1}$	0.37	0.45	0.51	V	< 7 counts
	13.3% $P_{in\_max}$	$V_{csth\_burst2}$	0.30	0.37	0.44	V	8 ~ 39 counts
	9.6% $P_{in\_max}$	$V_{csth\_burst3}$	0.23	0.31	0.37	V	40 ~ 191 counts
Leading Edge Blanking	Normal mode	$t_{LEB\_normal}$	-	220	-	ns	
	Burst mode	$t_{LEB\_burst}$	-	180	-	ns	
CS Input Bias Current		$I_{CSbias}$	-1.5	-0.2	-	$\mu A$	$V_{CS}=0V$

#### 4.3.7 CoolMOS™ Section

Parameter		Symbol	Limit Values			Unit	Test Condition
			min.	typ.	max.		
Drain Source Breakdown Voltage		$V_{(BR)DSS}$	800 870	- -	- -	V V	$T_j = 25^\circ C$ $T_j = 110^\circ C^{1)}$
Drain Source On-Resistance		$R_{DSon}$	- -	1.5 3.31	1.71 3.79	$\Omega$ $\Omega$	$T_j = 25^\circ C$ $T_j = 125^\circ C^{1)}$ at $I_D = 1.08A$
Effective output capacitance, energy related		$C_{o(er)}$	-	16	-	pF	$V_{DS} = 0V$ to 480V
Rise Time		$t_{rise}$	-	30 <sup>2)</sup>	-	ns	
Fall Time		$t_{fall}$	-	30 <sup>2)</sup>	-	ns	

1) The parameter is not subjected to production test - verified by design/characterization

2) Measured in a Typical Flyback Converter Application

## 5 Typical Controller Performance Characteristics

Characteristic graphs are normalized at  $T_a=25^\circ\text{C}$

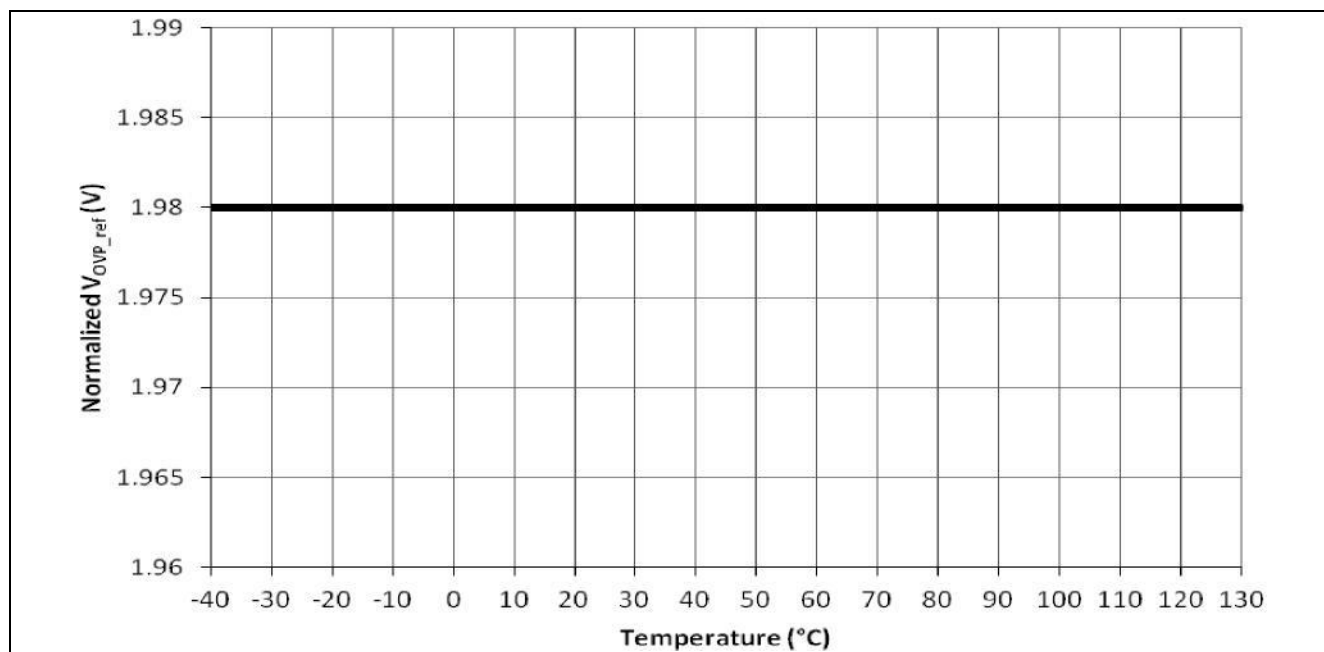


Figure 36: Line OVP ( $V_{\text{OVP\_ref}}$ ) vs.  $T_a$

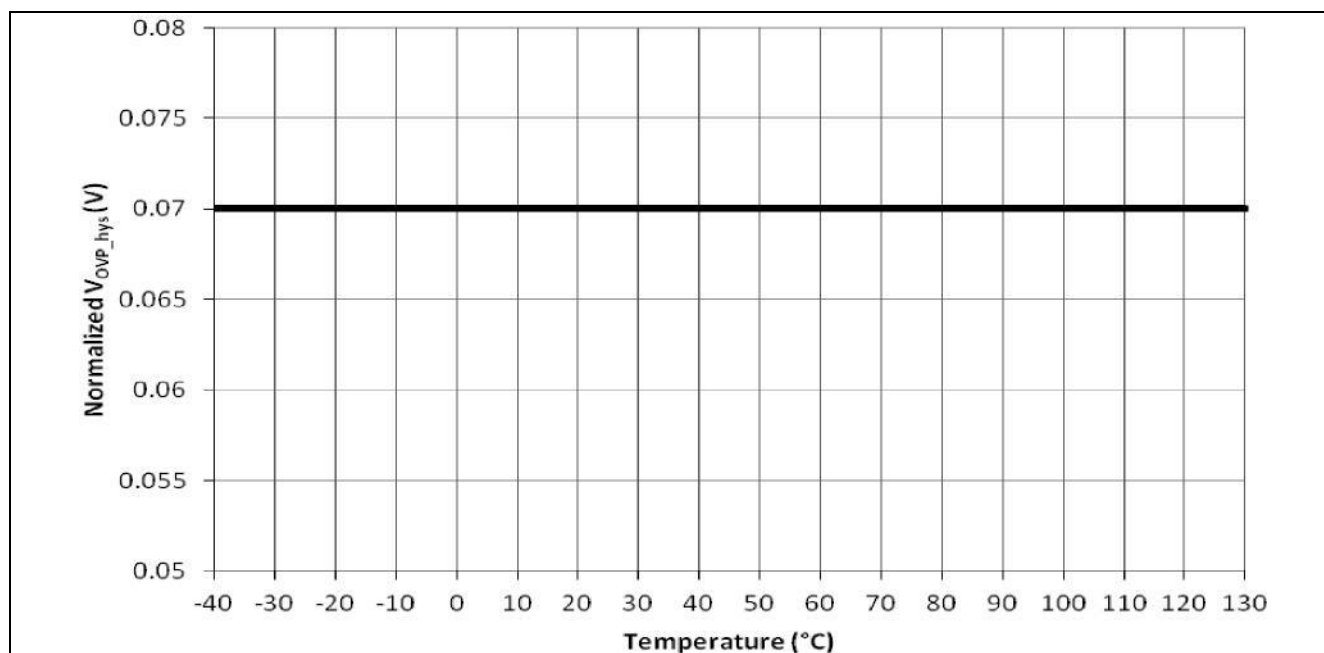


Figure 37: Hysteresis of Line OVP ( $V_{\text{OVP\_hys}}$ ) vs.  $T_a$

## 6 CoolMOS™ Performance Characteristics

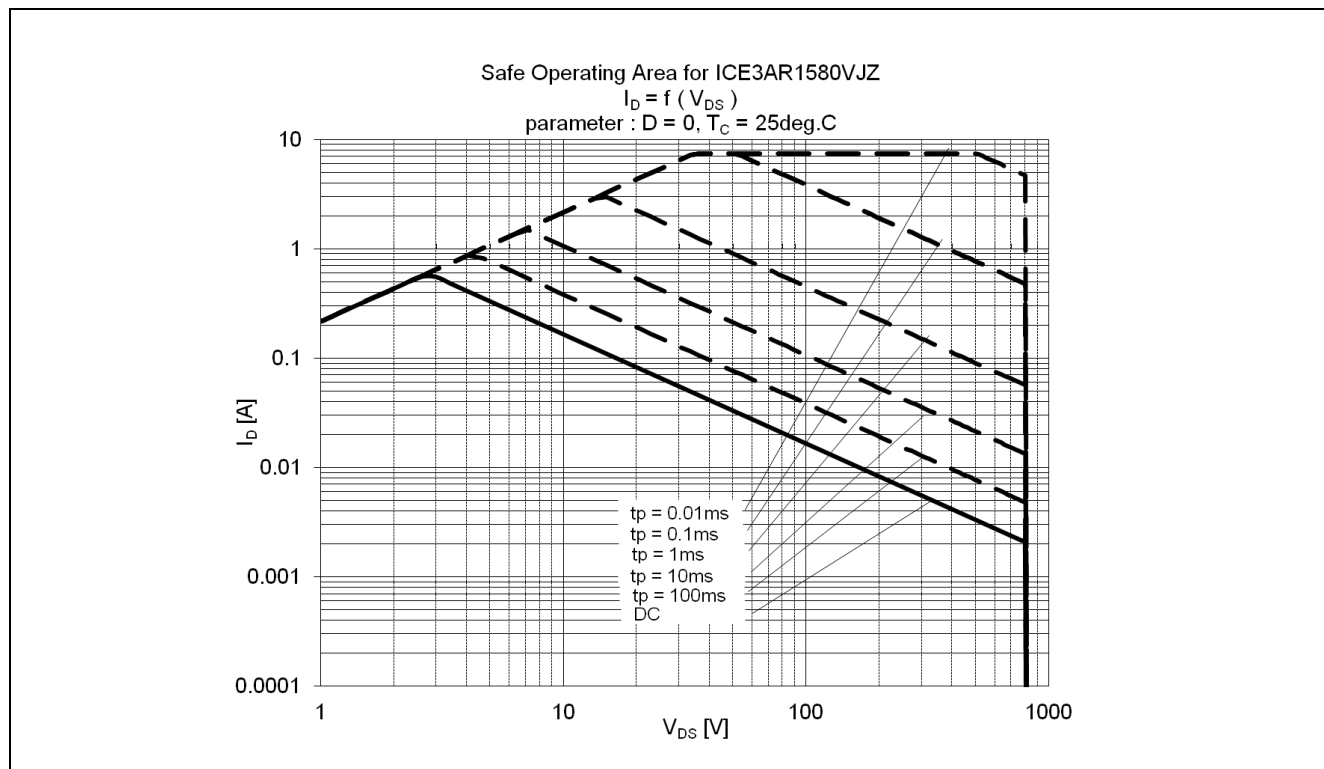


Figure 38: Safe Operating Area (SOA) curve for ICE3AR1580VJZ

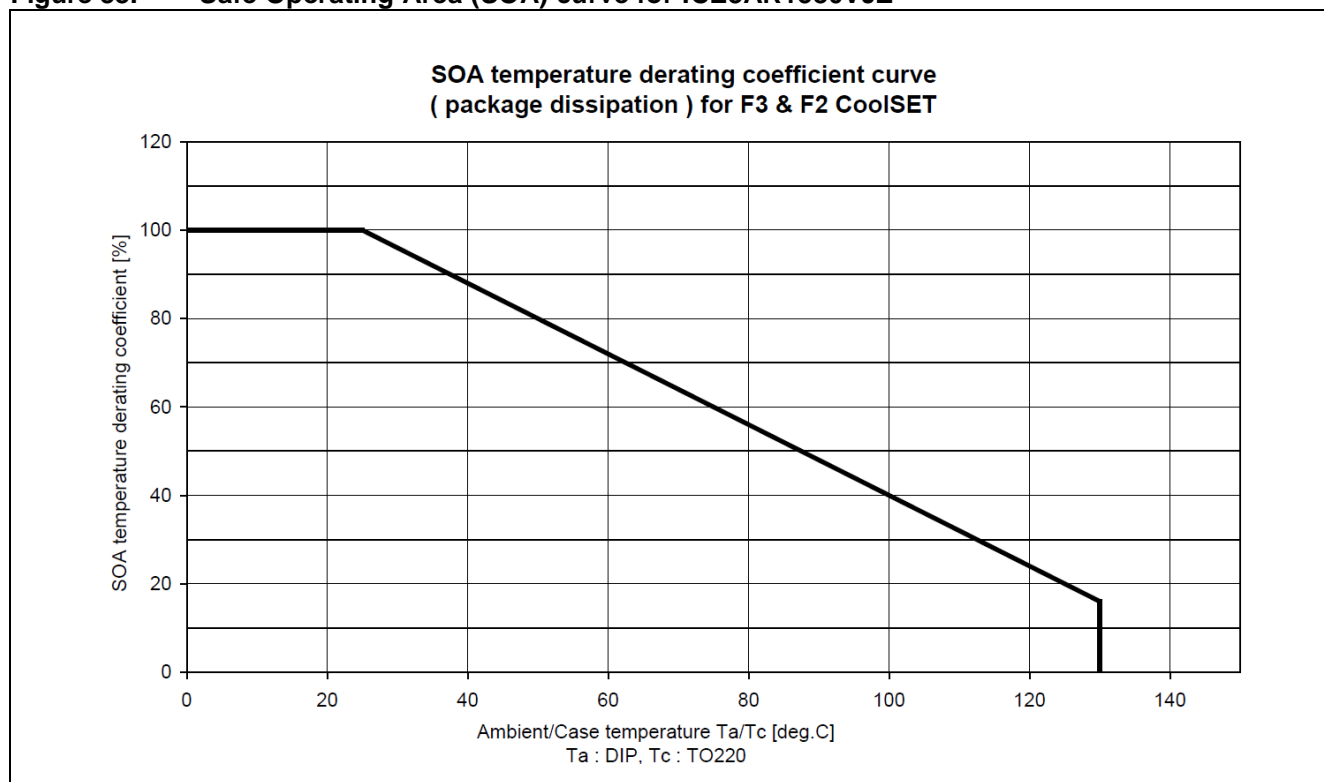


Figure 39: SOA temperature derating coefficient curve

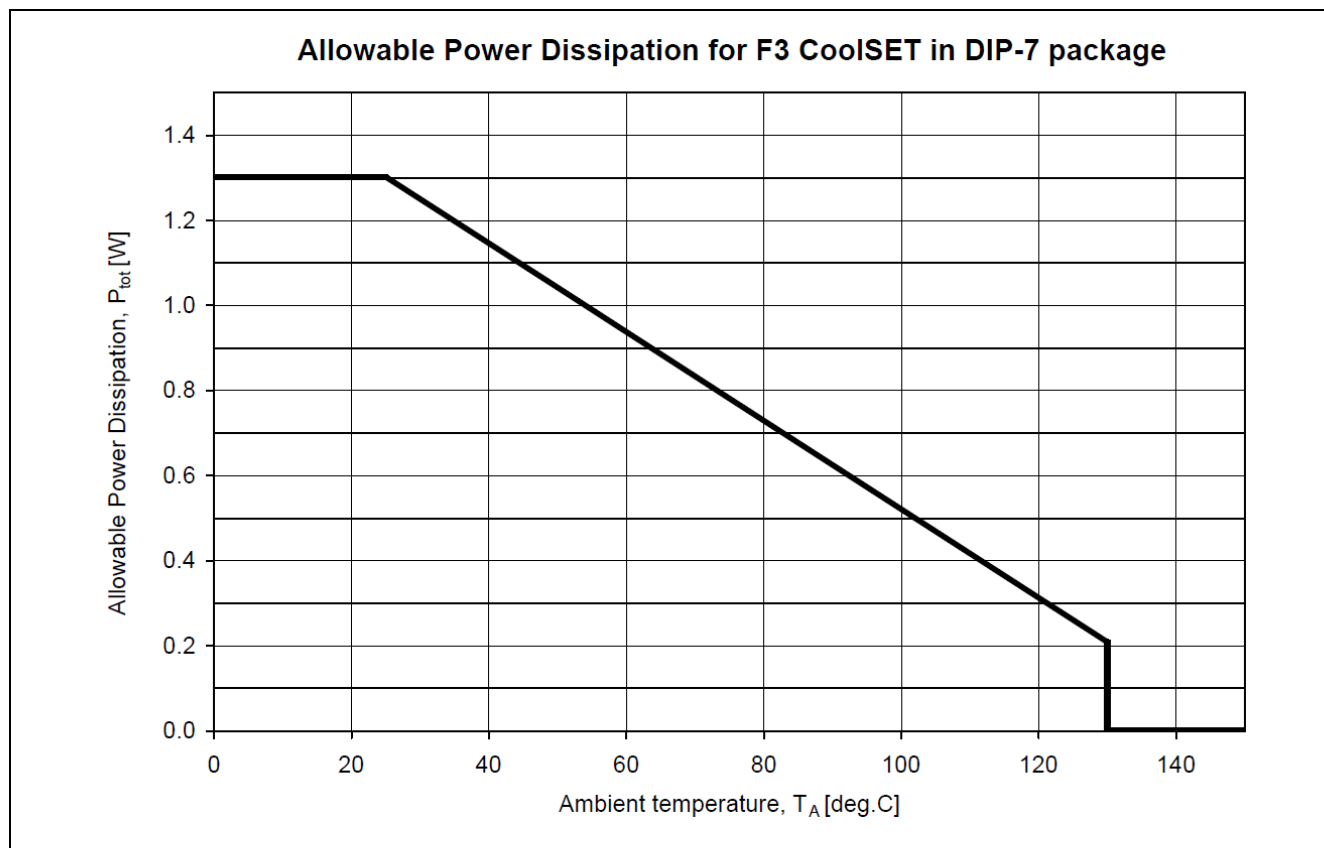


Figure 40: Power dissipation;  $P_{tot}=f(T_a)$

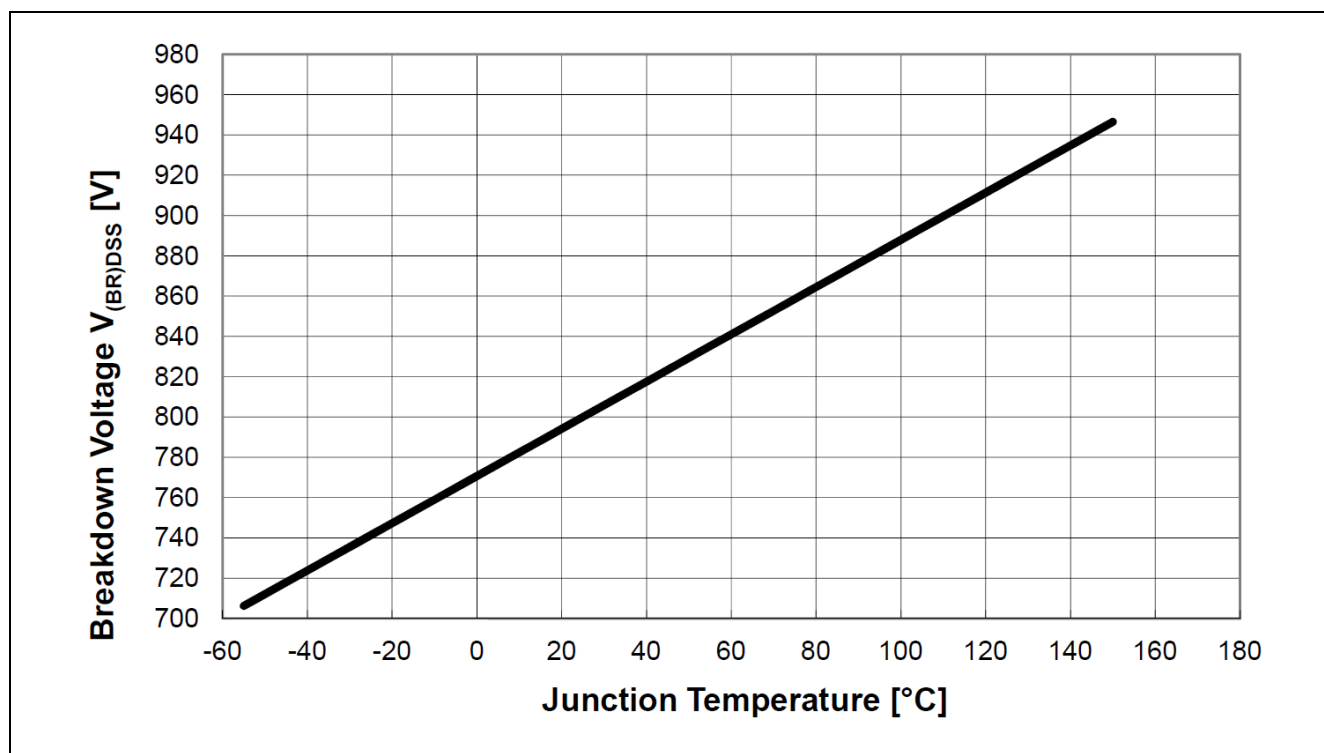
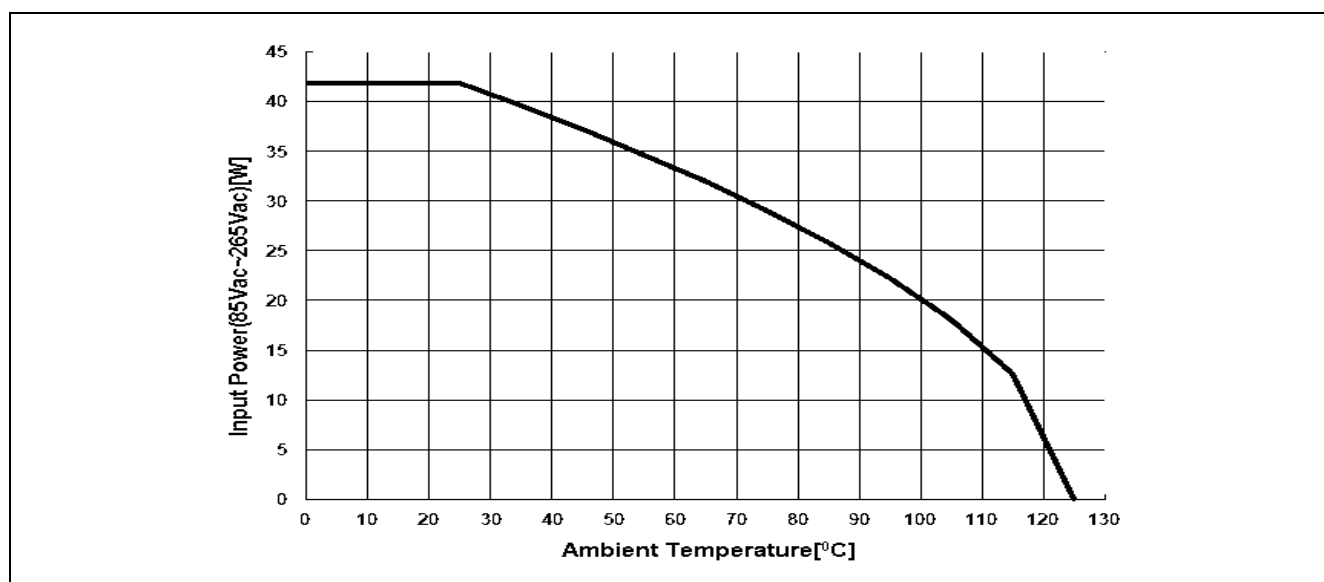


Figure 41: Drain-source breakdown voltage;  $V_{BR(DSS)}=f(T_j)$ ,  $I_D=0.25mA$

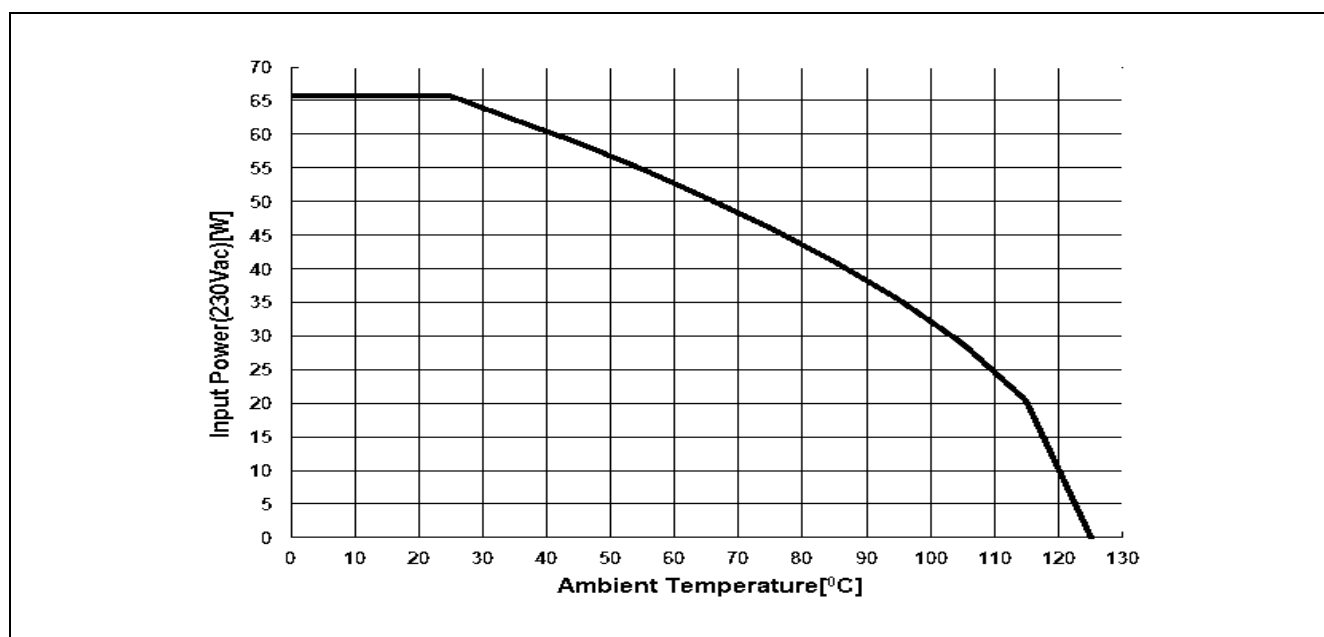
## 7 Input Power Curve

Two input power curves giving the typical input power versus ambient temperature are showed below;  $V_{in}=85\text{Vac}\sim 265\text{Vac}$  (Figure 42) and  $V_{in}=230\text{Vac}\pm 15\%$  (Figure 43). The curves are derived based on a typical discontinuous mode flyback model which considers either 50% maximum duty ratio or 100V maximum secondary to primary reflected voltage (higher priority). The calculation is based on no copper area as heatsink for the device. The input power already includes the power loss at input common mode choke, bridge rectifier and the CoolMOS™. The device saturation current ( $I_{D\_Puls}$  @  $T_j=125^\circ\text{C}$ ) is also considered.

To estimate the output power of the device, it is simply multiplying the input power at a particular operating ambient temperature with the estimated efficiency for the application. For example, a wide range input voltage (Figure 42), operating temperature is  $50^\circ\text{C}$ , estimated efficiency is 85%, then the estimated output power is 30W ( $36\text{W} * 85\%$ ).

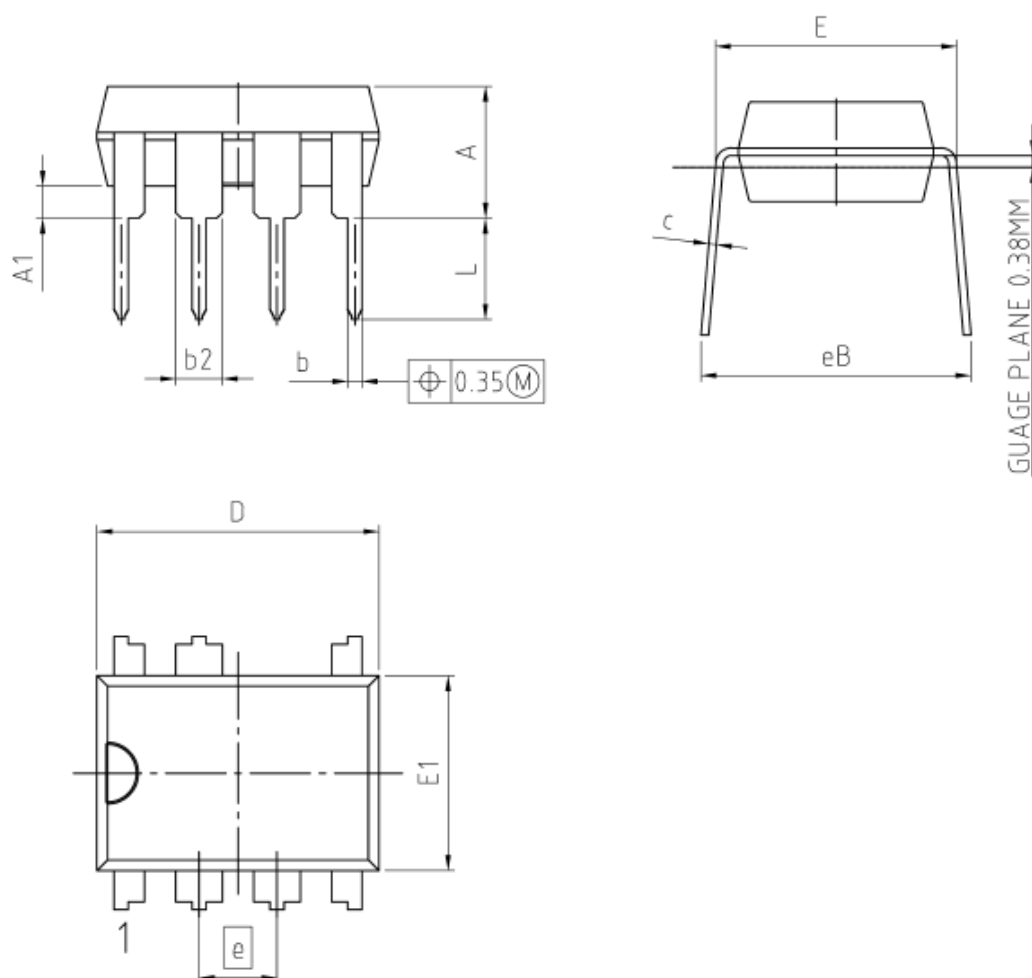


**Figure 42:** Input power curve  $V_{in}=85\sim 265\text{Vac}$ ;  $P_{in}=f(T_a)$



**Figure 43:** Input power curve  $V_{in}=230\text{Vac}$ ;  $P_{in}=f(T_a)$

## 8 Outline Dimension



1) DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS.

DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	-	4.57	-	0.180
A1	0.38	-	0.015	-
b	0.36	0.56	0.014	0.022
b2	-	1.70	-	0.067
c	0.20	0.36	0.008	0.014
D	9.10	9.77	0.358	0.385
E	7.49	8.26	0.295	0.325
E1	6.10	6.60	0.240	0.260
e	2.54 BSC		0.1 BSC	
N	7		7	
eB	7.90	10.90	0.311	0.429
L	2.92	-	0.115	-

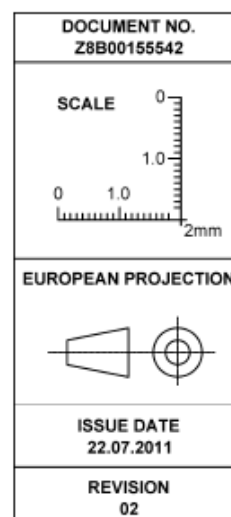


Figure 44: PG-DIP-7 (Pb-free lead plating Plastic Dual-in-Line Outline)

## 9 Marking

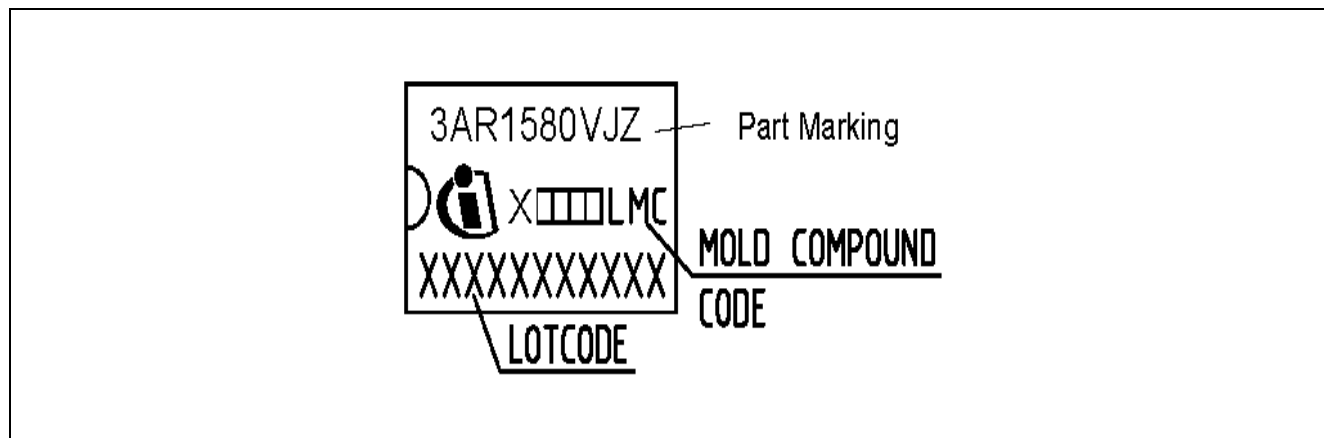
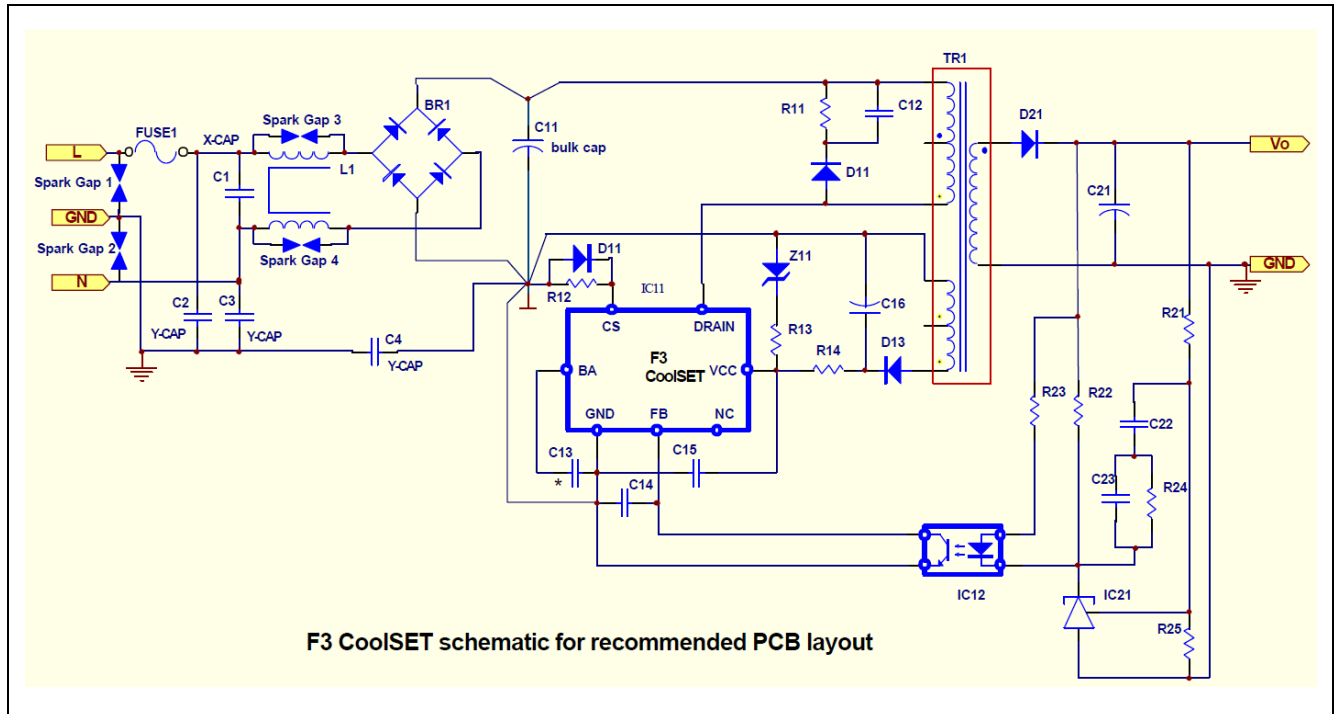


Figure 45: Marking for ICE3AR1580VJZ



## 10 Schematic for recommended PCB layout



**Figure 46: Schematic for recommended PCB layout**

General guideline for PCB layout design using F3 CoolSET™ (refer to Figure 46):

1. “Star Ground “at bulk capacitor ground, C11:  
“Star Ground “means all primary DC grounds should be connected to the ground of bulk capacitor C11 separately in one point. It can reduce the switching noise going into the sensitive pins of the CoolSET™ device effectively. The primary DC grounds include the followings.
  - a. DC ground of the primary auxiliary winding in power transformer, TR1, and ground of C16 and Z11.
  - b. DC ground of the current sense resistor, R12
  - c. DC ground of the CoolSET™ device, GND pin of IC11; the signal grounds from C13, C14, C15 and collector of IC12 should be connected to the GND pin of IC11 and then “star “connect to the bulk capacitor ground.
  - d. DC ground from bridge rectifier, BR1
  - e. DC ground from the bridging Y-capacitor, C4
2. High voltage traces clearance:  
High voltage traces should keep enough spacing to the nearby traces. Otherwise, arcing would incur.
  - a. 400V traces (positive rail of bulk capacitor C11) to nearby trace: > 2.0mm
  - b. 600V traces (drain voltage of CoolSET™ IC11) to nearby trace: > 2.5mm
3. Filter capacitor close to the controller ground:  
Filter capacitors, C13, C14 and C15 should be placed as close to the controller ground and the controller pin as possible so as to reduce the switching noise coupled into the controller.

**Schematic for recommended PCB layout**

Guideline for PCB layout design when >3KV lightning surge test applied (refer to Figure 46):

1. Add spark gap

Spark gap is a pair of saw-tooth like copper plate facing each other which can discharge the accumulated charge during surge test through the sharp point of the saw-tooth plate.

a. Spark Gap 3 and Spark Gap 4, input common mode choke,

L1: Gap separation is around 1.5mm (no safety concern)

b. Spark Gap 1 and Spark Gap 2, Live / Neutral to GROUND:

These 2 Spark Gaps can be used when the lightning surge requirement is >6KV.

230Vac input voltage application, the gap separation is around 5.5mm

115Vac input voltage application, the gap separation is around 3mm

2. Add Y-capacitor (C2 and C3) in the Live and Neutral to ground even though it is a 2-pin input

3. Add negative pulse clamping diode, D11 to the Current sense resistor, R12:

The negative pulse clamping diode can reduce the negative pulse going into the CS pin of the CoolSET™ and reduce the abnormal behavior of the CoolSET™. The diode can be a fast speed diode such as 1N4148.

The principle behind is to drain the high surge voltage from Live/Neutral to Ground without passing through the sensitive components such as the primary controller, IC11.

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